

Precision Analog Microcontroller, 12-Bit Analog I/O, ARM7TDMI MCU

Data Sheet **[ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)**

FEATURES

Analog I/O Multichannel, 12-bit, 1 MSPS ADC Up to 16 ADC channels¹ **Fully differential and single-ended modes 0 V to VREF analog input range 12-bit voltage output DACs Up to 4 DAC outputs available1 On-chip voltage reference On-chip temperature sensor (±3°C) Voltage comparator Microcontroller ARM7TDMI core, 16-bit/32-bit RISC architecture JTAG port supports code download and debug Clocking options Trimmed on-chip oscillator (±3%) External watch crystal External clock source up to 44 MHz 41.78 MHz PLL with programmable divider Memory 62 kB Flash/EE memory, 8 kB SRAM In-circuit download, JTAG-based debug Software-triggered in-circuit reprogrammability** **On-chip peripherals UART, 2× I2C and SPI serial I/O** Up to 40-pin GPIO port¹ **4× general-purpose timers Wake-up and watchdog timers (WDT) Power supply monitor 3-phase, 16-bit PWM generator1 Programmable logic array (PLA) External memory interface, up to 512 kB1 Power Specified for 3 V operation Active mode: 11 mA at 5 MHz, 40 mA at 41.78 MHz Packages and temperature range From 40-lead 6 mm × 6 mm LFCSP to 80-lead LQFP1 Fully specified for –40°C to +125°C operation Tools Low cost QuickStart development system Full third-party support**

APPLICATIONS

Industrial control and automation systems Smart sensors, precision instrumentation Base station systems, optical networking

Figure 1.

¹ Depending on part model. Se[e Ordering Guide](#page-100-0) for more information.

Rev. H [Document Feedback](https://form.analog.com/Form_Pages/feedback/documentfeedback.aspx?doc=ADuC7019_7020_7021_7022_7024_7025_7026_7027_7028_7029.pdf&product=ADuC7019%20ADuC7020%20ADuC7021%20ADuC7022%20ADuC7024%20ADuC7025%20ADuC7026%20ADuC7027%20ADuC7028%20ADuC7029&rev=H)

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 ©2005–2018 Analog Devices, Inc. All rights reserved. [Technical Support](http://www.analog.com/en/content/technical_support_page/fca.html) www.analog.com

TABLE OF CONTENTS

REVISION HISTORY

12/2015—Rev. F to Rev. G

5/2013—Rev. E to Rev. F

7/2012—Rev. D to Rev. E

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

5/2011—Rev. C to Rev. D

12/2009—Rev. B to Rev. C

3/2007—Rev. A to Rev. B

1/2006—Rev. 0 to Rev. A

10/2005—Revision 0: Initial Version

GENERAL DESCRIPTION

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 a](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)re fully integrated, 1 MSPS, 12-bit data acquisition systems incorporating high performance multichannel ADCs, 16-bit/32-bit MCUs, and Flash®/EE memory on a single chip.

The ADC consists of up to 12 single-ended inputs. An additional four inputs are available but are multiplexed with the four DAC output pins. The four DAC outputs are available only on certain models (ADuC7020, ADuC7026, ADuC7028, and ADuC7029). However, in many cases where the DAC outputs are not present, these pins can still be used as additional ADC inputs, giving a maximum of 16 ADC input channels. The ADC can operate in single-ended or differential input mode. The ADC input voltage is 0 V to VREF. A low drift band gap reference, temperature sensor, and voltage comparator complete the ADC peripheral set.

Depending on the part model, up to four buffered voltage output DACs are available on-chip. The DAC output range is programmable to one of three voltage ranges.

The devices operate from an on-chip oscillator and a PLL generating an internal high frequency clock of 41.78 MHz (UCLK). This clock is routed through a programmable clock divider from which the MCU core clock operating frequency is generated. The microcontroller core is an ARM7TDMI®, 16-bit/32-bit RISC machine, which offers up to 41 MIPS peak performance. Eight kilobytes of SRAM and 62 kilobytes of nonvolatile Flash/EE memory are provided on-chip. The ARM7TDMI core views all memory and registers as a single linear array.

On-chip factory firmware supports in-circuit serial download via the UART or I²C serial interface port; nonintrusive emulation is also supported via the JTAG interface. These features are incorporated into a low cost QuickStart™ development system supporting this MicroConverter® family.

The parts operate from 2.7 V to 3.6 V and are specified over an industrial temperature range of −40°C to +125°C. When operating at 41.78 MHz, the power dissipation is typically 120 mW. The [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 a](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)re available in a variety of memory models and packages (see [Ordering Guide\)](#page-100-0).

Figure 2. ADuC7020 Functional Block Diagram

Figure 4. ADuC7022 Functional Block Diagram

Figure 7. ADuC7026 Functional Block Diagram

Figure 8. ADuC7027 Functional Block Diagram

Figure 9. ADuC7028 Functional Block Diagram

Figure 10. ADuC7029 Functional Block Diagram

DETAILED BLOCK DIAGRAM

SPECIFICATIONS

 $AV_{DD} = IOV_{DD} = 2.7 V$ to 3.6 V, $V_{REF} = 2.5 V$ internal reference, $f_{CORE} = 41.78 MHz$, $T_A = -40°C$ to +125°C, unless otherwise noted.

¹ All ADC channel specifications are guaranteed during normal MicroConverter core operation.

² Apply to all ADC input channels.

³ Measured using the factory-set default values in the ADC offset register (ADCOF) and gain coefficient register (ADCGN).
⁴ Not production tested but supported by design and/or characterization data on production relea

⁵ Measured using the factory-set default values in ADCOF and ADCGN with an externa[l AD845](http://www.analog.com/AD845?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) op amp as an input buffer stage as shown i[n Figure 59.](#page-49-1) Based on external ADC system components; the user may need to execute a system calibration to remove external endpoint errors and achieve these specifications (see th[e Calibration](#page-50-0) section).

 6 The input signal can be centered on any dc common-mode voltage (V_{CM}) as long as this value is within the ADC voltage input range specified.

⁷ DAC linearity is calculated using a reduced code range of 100 to 3995.

8 DAC gain error is calculated using a reduced code range of 100 to internal 2.5 V V_{REF}.
9 Endurance is qualified as per JEDEC Standard 22, Method A117 and measured at −40°C, +25°C, +85°C, and +125°C.

 10 Retention lifetime equivalent at junction temperature (T_J) = 85°C as per JEDEC Standard 22m, Method A117. Retention lifetime derates with junction temperature.

¹¹ Test carried out with a maximum of eight I/Os set to a low output level.

¹² See the POWCON register.

¹³ Power supply current consumption is measured in normal, pause, and sleep modes under the following conditions: normal mode with 3.6 V supply, pause mode with
3.6 V supply, and sleep mode with 3.6 V supply.

 14 IOV_{DD} power supply current decreases typically by 2 mA during a Flash/EE erase cycle.

¹⁵ On th[e ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22,](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) this current must be added to the AV_{DD} current.

TIMING SPECIFICATIONS

Table 2. External Memory Write Cycle

1 Se[e Table 78.](#page-68-0)

Figure 12. External Memory Write Cycle (Se[e Table 78\)](#page-68-0)

Table 3. External Memory Read Cycle

¹ See Table 78.

Figure 13. External Memory Read Cycle (Se[e Table 78\)](#page-68-0)

Table 4. I2 C Timing in Fast Mode (400 kHz)

 1 t_{HCLK} depends on the clock divider or CD bits in the POWCON MMR. t_{HCLK} = t_{UCLK}/2^{CD}; see Figure 67.

Table 5. I2 C Timing in Standard Mode (100 kHz)

 1 t_{HCLK} depends on the clock divider or CD bits in the POWCON MMR. t_{HCLK} = t_{UCLK}/2^{CD}; see Figure 67.

Figure 14. PC Compatible Interface Timing

Table 6. SPI Master Mode Timing (Phase Mode = 1)

 1 t_{HCLK} depends on the clock divider or CD bits in the POWCONMMR. t_{HCLK} = t_{UCLK}/2^{CD}; see Figure 67.
² tugu = 23.9 ns. It corresponds to the 41.78 MHz internal clock from the PLL before the clock divide

 $t_{\text{UCRK}} = 23.9$ ns. It corresponds to the 41.78 MHz internal clock from the PLL before the clock divider; see Figure 67.

Figure 15. SPI Master Mode Timing (Phase Mode = 1)

Table 7. SPI Master Mode Timing (Phase Mode = 0)

¹ t_{HCLK} depends on the clock divider or CD bits in the POWCONMMR. t_{HCLK} = t_{UCLK}/2^{cD}; see Figure 67.
² t_{UCLK} = 23.9 ns. It corresponds to the 41.78 MHz internal clock from the PLL before the clock divider; see

Figure 16. SPI Master Mode Timing (Phase Mode = 0)

Table 8. SPI Slave Mode Timing (Phsae Mode = 1)

 1 t_{UCLK} = 23.9 ns. It corresponds to the 41.78 MHz internal clock from the PLL before the clock divider; see Figure 67.
² t_{HCLK} depends on the clock divider or CD bits in the POWCONMMR. t_{HCLK} = t_{UCLK}/2^{CD}; s

Figure 17. SPI Slave Mode Timing (Phase Mode = 1)

Table 9. SPI Slave Mode Timing (Phase Mode = 0)

¹ t_{ucuk} = 23.9 ns. It corresponds to the 41.78 MHz internal clock from the PLL before the clock divider; see Figure 67.
² t_{HCLK} depends on the clock divider or CD bits in the POWCONMMR. t_{HCLK} = t_{UCLK}/2^{CD}; see

Figure 18. SPI Slave Mode Timing (Phase Mode = 0)

ABSOLUTE MAXIMUM RATINGS

 $AGND = REFGND = DACGND = GND_{REF}$, $T_A = 25^{\circ}C$, unless otherwise noted.

Table 10.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Only one absolute maximum rating can be applied at any one time.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

ADuC7019/ADuC7020/ADuC7021/ADuC7022

Table 11. Pin Function Descriptions (ADuC7019/ADuC7020/ADuC7021/ADuC7022)

ADuC7024/ADuC7025

Figure 24. 64-Lead LQFP Pin Configuration (ADuC7024/ADuC7025)

Table 12. Pin Function Descriptions (ADuC7024/ADuC7025 64-Lead LFCSP_VQ and 64-Lead LQFP)

ADuC7026/ADuC7027

Figure 25. 80-Lead LQFP Pin Configuration (ADuC7026/ADuC7027)

ADuC7028

Figure 26. 64-Ball CSP_BGA Pin Configuration (ADuC7028)

Table 14. Pin Function Descriptions (ADuC7028)

ADuC7029

```
7 6 45 3 2 1
0\ 0\ 0\ 0\ 0\ 0\ 0A
0\quad 0\quad 0\quad 0\quad 0\quad 0\quad 0B
\circ \circ \circ \circ \circ \circ \circC
0 0 0 0 0 0 0 0D
\begin{array}{cccccccccccccc} \circ & \circ \end{array}E
\begin{array}{cccccccccccccc} \circ & \circ \end{array}F
0 0 0 0 0 0 0 0G
         BOTTOM VIEW
          (Not to Scale)
```
Figure 27. 49-Ball CSP_BGA Pin Configuration (ADuC7029)

04955-088

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 28. Typical INL Error, f_S = 774 kSPS

Figure 33. Typical Worst-Case (Positive (WCP)and Negative (WCN)) DNL Error vs. V_{REF}, f_S = 774 kSPS

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Figure 38. On-Chip Temperature Sensor Voltage Output vs. Temperature

Figure 39. Current Consumption vs. Temperature at $CD = 0$

Figure 41. Current Consumption vs. Temperature at $CD = 7$

Figure 42. Current Consumption vs. Temperature in Sleep Mode

Figure 43. Current Consumption vs. Sampling Frequency

TERMINOLOGY ADC SPECIFICATIONS

Integral Nonlinearity (INL)

The maximum deviation of any code from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale, a point ½ LSB below the first code transition, and full scale, a point ½ LSB above the last code transition.

Differential Nonlinearity (DNL)

The difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

Offset Error

The deviation of the first code transition (0000 . . . 000) to $(0000 \ldots 001)$ from the ideal, that is, $+\frac{1}{2}$ LSB.

Gain Error

The deviation of the last code transition from the ideal AIN voltage (full scale − 1.5 LSB) after the offset error has been adjusted out.

Signal to (Noise + Distortion) Ratio (SINAD)

The measured ratio of signal to (noise + distortion) at the output of the ADC. The signal is the rms amplitude of the fundamental. Noise is the rms sum of all nonfundamental signals up to half the sampling frequency $(f_S/2)$, excluding dc. The ratio is dependent upon the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise.

The theoretical signal to (noise + distortion) ratio for an ideal N-bit converter with a sine wave input is given by

Signal to (*Noise* + *Distortion*) = (6.02 *N* + 1.76) dB

Thus, for a 12-bit converter, this is 74 dB.

Total Harmonic Distortion (THD)

The ratio of the rms sum of the harmonics to the fundamental.

DAC SPECIFICATIONS

Relative Accuracy

Otherwise known as endpoint linearity, relative accuracy is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for zero error and full-scale error.

Voltage Output Settling Time

The amount of time it takes the output to settle to within a 1 LSB level for a full-scale input change.

OVERVIEW OF THE ARM7TDMI CORE

The ARM7® core is a 32-bit reduced instruction set computer (RISC). It uses a single 32-bit bus for instruction and data. The length of the data can be eight bits, 16 bits, or 32 bits. The length of the instruction word is 32 bits.

The ARM7TDMI is an ARM7 core with four additional features.

- T support for the thumb (16-bit) instruction set.
- D support for debug.
- M support for long multiplications.
- I includes the EmbeddedICE module to support embedded system debugging.

THUMB MODE (T)

An ARM instruction is 32 bits long. The ARM7TDMI processor supports a second instruction set that is compressed into 16 bits, called the thumb instruction set. Faster execution from 16-bit memory and greater code density can usually be achieved by using the thumb instruction set instead of the ARM instruction set, which makes the ARM7TDMI core particularly suitable for embedded applications.

However, the thumb mode has two limitations.

- Thumb code typically requires more instructions for the same job. As a result, ARM code is usually best for maximizing the performance of time-critical code.
- The thumb instruction set does not include some of the instructions needed for exception handling, which automatically switches the core to ARM code for exception handling.

See the ARM7TDMI user guide for details on the core architecture, the programming model, and both the ARM and ARM thumb instruction sets.

LONG MULTIPLY (M)

The ARM7TDMI instruction set includes four extra instructions that perform 32-bit by 32-bit multiplication with a 64-bit result, and 32-bit by 32-bit multiplication-accumulation (MAC) with a 64-bit result. These results are achieved in fewer cycles than required on a standard ARM7 core.

EmbeddedICE (I)

EmbeddedICE provides integrated on-chip support for the core. The EmbeddedICE module contains the breakpoint and watchpoint registers that allow code to be halted for debugging purposes. These registers are controlled through the JTAG test port.

When a breakpoint or watchpoint is encountered, the processor halts and enters debug state. Once in a debug state, the processor registers can be inspected as well as the Flash/EE, SRAM, and memory mapped registers.

EXCEPTIONS

ARM supports five types of exceptions and a privileged processing mode for each type. The five types of exceptions are

- Normal interrupt or IRQ, which is provided to service general-purpose interrupt handling of internal and external events.
- Fast interrupt or FIQ, which is provided to service data transfers or communication channels with low latency. FIQ has priority over IRQ.
- Memory abort.
- Attempted execution of an undefined instruction.
- Software interrupt instruction (SWI), which can be used to make a call to an operating system.

Typically, the programmer defines interrupt as IRQ, but for higher priority interrupt, that is, faster response time, the programmer can define interrupt as FIQ.

ARM REGISTERS

ARM7TDMI has a total of 37 registers: 31 general-purpose registers and six status registers. Each operating mode has dedicated banked registers.

When writing user-level programs, 15 general-purpose 32-bit registers (R0 to R14), the program counter (R15), and the current program status register (CPSR) are usable. The remaining registers are used for system-level programming and exception handling only.

When an exception occurs, some of the standard registers are replaced with registers specific to the exception mode. All exception modes have replacement banked registers for the stack pointer (R13) and the link register (R14), as represented in [Figure 44.](#page-39-0) The fast interrupt mode has more registers (R8 to R12) for fast interrupt processing. This means that interrupt processing can begin without the need to save or restore these registers and, thus, save critical time in the interrupt handling process.

04955-007

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

More information relative to the programmer's model and the ARM7TDMI core architecture can be found in the following materials from ARM:

- DDI0029G, *ARM7TDMI Technical Reference Manual*
- DDI-0100, *ARM Architecture Reference Manual*

INTERRUPT LATENCY

The worst-case latency for a fast interrupt request (FIQ) consists of the following:

- The longest time the request can take to pass through the synchronizer
- The time for the longest instruction to complete (the longest instruction is an LDM) that loads all the registers including the PC
- The time for the data abort entry
- The time for FIQ entry

At the end of this time, the ARM7TDMI executes the instruction at 0x1C (FIQ interrupt vector address). The maximum total time is 50 processor cycles, which is just under 1.2 µs in a system using a continuous 41.78 MHz processor clock.

The maximum interrupt request (IRQ) latency calculation is similar but must allow for the fact that FIQ has higher priority and may delay entry into the IRQ handling routine for an arbitrary length of time. This time can be reduced to 42 cycles if the LDM command is not used. Some compilers have an option to compile without using this command. Another option is to run the part in thumb mode where the time is reduced to 22 cycles.

The minimum latency for FIQ or IRQ interrupts is a total of five cycles, which consist of the shortest time the request can take through the synchronizer plus the time to enter the exception mode.

Note that the ARM7TDMI always runs in ARM (32-bit) mode when in privileged modes, for example, when executing interrupt service routines.

MEMORY ORGANIZATION

Th[e ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 i](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ncorporate two separate blocks of memory: 8 kB of SRAM and 64 kB of on-chip Flash/EE memory. The 62 kB of on-chip Flash/EE memory is available to the user, and the remaining 2 kB are reserved for the factory-configured boot page. These two blocks are mapped as shown i[n Figure 45.](#page-41-0)

Figure 45. Physical Memory Map

Note that by default, after a reset, the Flash/EE memory is mirrored at Address 0x00000000. It is possible to remap the SRAM at Address 0x00000000 by clearing Bit 0 of the REMAP MMR. This remap function is described in more detail in the [Flash/EE Memory](#page-41-1) section.

MEMORY ACCESS

The ARM7 core sees memory as a linear array of a 2^{32} byte location where the different blocks of memory are mapped as outlined in [Figure 45.](#page-41-0)

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 m](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)emory organizations are configured in little endian format, which means that the least significant byte is located in the lowest byte address, and the most significant byte is in the highest byte address.

FLASH/EE MEMORY

The total 64 kB of Flash/EE memory is organized as $32 \text{ k} \times 16 \text{ bits}$; 31 k \times 16 bits is user space and 1 k \times 16 bits is reserved for the on-chip kernel. The page size of this Flash/EE memory is 512 bytes.

Sixty-two kilobytes of Flash/EE memory are available to the user as code and nonvolatile data memory. There is no distinction between data and program because ARM code shares the same space. The real width of the Flash/EE memory is 16 bits, which means that in ARM mode (32-bit instruction), two accesses to the Flash/EE are necessary for each instruction fetch. It is therefore recommended to use thumb mode when executing from Flash/EE memory for optimum access speed. The maximum access speed for the Flash/EE memory is 41.78 MHz in thumb mode and 20.89 MHz in full ARM mode. More details about Flash/EE access time are outlined in the [Execution Time from SRAM and Flash/EE s](#page-54-0)ection.

SRAM

Eight kilobytes of SRAM are available to the user, organized as $2 k \times 32$ bits, that is, two words. ARM code can run directly from SRAM at 41.78 MHz, given that the SRAM array is configured as a 32-bit wide memory array. More details about SRAM access time are outlined in the [Execution Time from](#page-54-0) [SRAM and Flash/EE](#page-54-0) section.

MEMORY MAPPED REGISTERS

The memory mapped register (MMR) space is mapped into the upper two pages of the memory array and accessed by indirect addressing through the ARM7 banked registers.

The MMR space provides an interface between the CPU and all on-chip peripherals. All registers, except the core registers, reside in the MMR area. All shaded locations shown in [Figure 47 a](#page-42-0)re unoccupied or reserved locations and should not be accessed by user software[. Table 16](#page-42-1) shows the full MMR memory map.

The access time for reading from or writing to an MMR depends on the advanced microcontroller bus architecture (AMBA) bus used to access the peripheral. The processor has two AMBA buses: the advanced high performance bus (AHB) used for system modules and the advanced peripheral bus (APB) used for lower performance peripheral. Access to the AHB is one cycle, and access to the APB is two cycles. All peripherals on the [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 a](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)re on the APB except the Flash/EE memory, the GPIOs (see [Table 78\)](#page-68-0), and the PWM.

<u> 2222222</u>

Figure 47. Memory Mapped Registers

04955-010

oro. 04955-

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 16. Complete MMR List

¹ Depends on the level on the external interrupt pins (P0.4, P0.5, P1.4, and P1.5).

System Control Address Base = 0xFFFF0200

¹ Depends on the model.

Timer Address Base = 0xFFFF0300

PLL Base Address = 0xFFFF0400

PSM Address Base = 0xFFFF0440

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

External Memory Base Address = 0xFFFFF000

Flash/EE Base Address = 0xFFFFF800

 $1 X = 0, 1, 2,$ or 3.

PWM Base Address = 0xFFFFFC00

ADC CIRCUIT OVERVIEW

The analog-to-digital converter (ADC) incorporates a fast, multichannel, 12-bit ADC. It can operate from 2.7 V to 3.6 V supplies and is capable of providing a throughput of up to 1 MSPS when the clock source is 41.78 MHz. This block provides the user with a multichannel multiplexer, a differential track-and-hold, an on-chip reference, and an ADC.

The ADC consists of a 12-bit successive approximation converter based around two capacitor DACs. Depending on the input signal configuration, the ADC can operate in one of three modes.

- Fully differential mode, for small and balanced signals
- Single-ended mode, for any single-ended signals
- Pseudo differential mode, for any single-ended signals, taking advantage of the common-mode rejection offered by the pseudo differential input

The converter accepts an analog input range of $0 \,$ V to V_{REF} when operating in single-ended or pseudo differential mode. In fully differential mode, the input signal must be balanced around a common-mode voltage (V_{CM}) in the 0 V to AV_{DD} range with a maximum amplitude of 2 V_{REF} (see [Figure 48\)](#page-45-0).

Figure 48. Examples of Balanced Signals in Fully Differential Mode

A high precision, low drift, factory calibrated, 2.5 V reference is provided on-chip. An external reference can also be connected as described in the [Band Gap Reference s](#page-50-1)ection.

Single or continuous conversion modes can be initiated in the software. An external CONV_{START} pin, an output generated from the on-chip PLA, or a Timer0 or Timer1 overflow can also be used to generate a repetitive trigger for ADC conversions.

A voltage output from an on-chip band gap reference proportional to absolute temperature can also be routed through the front-end ADC multiplexer, effectively an additional ADC channel input. This facilitates an internal temperature sensor channel that measures die temperature to an accuracy of $\pm 3^{\circ}$ C.

TRANSFER FUNCTION

Pseudo Differential and Single-Ended Modes

In pseudo differential or single-ended mode, the input range is 0∇ to V_{REF} . The output coding is straight binary in pseudo differential and single-ended modes with

1 LSB = *FS*/4096, or $2.5 \text{ V}/4096 = 0.61 \text{ mV}$, or 610 μV when V_{REF} = 2.5 V The ideal code transitions occur midway between successive integer LSB values (that is, 1/2 LSB, 3/2 LSB, 5/2 LSB, … , FS − 3/2 LSB). The ideal input/output transfer characteristic is shown in [Figure 49.](#page-45-1)

Figure 49. ADC Transfer Function in Pseudo Differential or Single-Ended Mode

Fully Differential Mode

The amplitude of the differential signal is the difference between the signals applied to the V_{IN+} and V_{IN-} input voltage pins (that is, $V_{IN+} - V_{IN-}$). The maximum amplitude of the differential signal is, therefore, $-V_{REF}$ to $+V_{REF}$ p-p (that is, $2 \times V_{REF}$). This is regardless of the common mode (CM). The common mode is the average of the two signals, for example, $(V_{IN+} + V_{IN-})/2$, and is, therefore, the voltage that the two inputs are centered on. This results in the span of each input being $CM \pm V_{REF}/2$. This voltage has to be set up externally, and its range varies with VREF (see th[e Driving the Analog Inputs s](#page-49-0)ection).

The output coding is twos complement in fully differential mode with 1 LSB = 2 V_{REF}/4096 or 2×2.5 V/4096 = 1.22 mV when V_{REF} = 2.5 V. The output result is ± 11 bits, but this is shifted by 1 to the right. This allows the result in ADCDAT to be declared as a signed integer when writing C code. The designed code transitions occur midway between successive integer LSB values (that is, 1/2 LSB, 3/2 LSB, 5/2 LSB, … , FS − 3/2 LSB). The ideal input/output transfer characteristic is shown i[n Figure 50.](#page-45-2)

Figure 50. ADC Transfer Function in Differential Mode

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

TYPICAL OPERATION

Once configured via the ADC control and channel selection registers, the ADC converts the analog input and provides a 12-bit result in the ADC data register.

The top four bits are the sign bits. The 12-bit result is placed from Bit 16 to Bit 27, as shown i[n Figure 51.](#page-46-1) Again, it should be noted that, in fully differential mode, the result is represented in twos complement format. In pseudo differential and singleended modes, the result is represented in straight binary format.

The same format is used in DACxDAT, simplifying the software.

Current Consumption

The ADC in standby mode, that is, powered up but not converting, typically consumes 640 μA. The internal reference adds 140 μA. During conversion, the extra current is 0.3 μA multiplied by the sampling frequency (in kilohertz (kHz)). [Figure 43 s](#page-37-0)hows the current consumption vs. the sampling frequency of the ADC.

Timing

[Figure 52 g](#page-46-2)ives details of the ADC timing. Users control the ADC clock speed and the number of acquisition clocks in the ADCCON MMR. By default, the acquisition time is eight clocks and the clock divider is 2. The number of extra clocks (such as bit trial or write) is set to 19, which gives a sampling rate of 774 kSPS. For conversion on the temperature sensor, the ADC acquisition time is automatically set to 16 clocks, and the ADC clock divider is set to 32. When using multiple channels, including the temperature sensor, the timing settings revert to the user-defined settings after reading the temperature sensor channel.

Figure 52. ADC Timing

ADuC7019

The ADuC7019 is identical to the ADuC7020 except for one buffered ADC channel, ADC3, and it has only three DACs. The output buffer of the fourth DAC is internally connected to the ADC3 channel as shown i[n Figure 53.](#page-46-3)

Note that the DAC3 output pin must be connected to a 10 nF capacitor to AGND. This channel should be used to measure dc voltages only. ADC calibration may be necessary on this channel.

MMRS INTERFACE

The ADC is controlled and configured via the eight MMRs described in this section.

Table 17. ADCCON Register

ADCCON is an ADC control register that allows the programmer to enable the ADC peripheral, select the mode of operation of the ADC (in single-ended mode, pseudo differential mode, or fully differential mode), and select the conversion type. This MMR is described in [Table 18.](#page-47-2)

Table 18. ADCCON MMR Bit Designations

Table 19. ADCCP Register

ADCCP is an ADC positive channel selection register. This MMR is described in [Table 20.](#page-47-3)

¹ ADC and DAC channel availability depends on the part model. See Ordering [Guide](#page-100-0) for details.

Table 21. ADCCN Register

ADCCN is an ADC negative channel selection register. This MMR is described in [Table 22.](#page-48-5)

Table 23. ADCSTA Register

ADCSTA is an ADC status register that indicates when an ADC conversion result is ready. The ADCSTA register contains only one bit, ADCReady (Bit 0), representing the status of the ADC. This bit is set at the end of an ADC conversion, generating an ADC interrupt. It is cleared automatically by reading the ADCDAT MMR. When the ADC is performing a conversion, the status of the ADC can be read externally via the ADCBUSY pin. This pin is high during a conversion. When the conversion is finished, ADC_{BUSY} goes back low. This information can be available on P0.5 (see the [General-Purpose Input/Output](#page-67-6) section) if enabled in the ADCCON register.

Table 24. ADCDAT Register

ADCDAT is an ADC data result register. It holds the 12-bit ADC result as shown i[n Figure 51.](#page-46-1)

Table 25. ADCRST Register

ADCRST resets the digital interface of the ADC. Writing any value to this register resets all the ADC registers to their default values.

Table 26. ADCGN Register

ADCGN is a 10-bit gain calibration register.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 27. ADCOF Register

ADCOF is a 10-bit offset calibration register.

CONVERTER OPERATION

The ADC incorporates a successive approximation (SAR) architecture involving a charge-sampled input stage. This architecture can operate in three modes: differential, pseudo differential, and single-ended.

Differential Mode

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 e](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ach contain a successive approximation ADC based on two capacitive DACs. [Figure 54 a](#page-48-6)nd [Figure 55 s](#page-48-7)how simplified schematics of the ADC in acquisition and conversion phase, respectively. The ADC comprises control logic, a SAR, and two capacitive DACs. In [Figure 54 \(](#page-48-6)the acquisition phase), SW3 is closed and SW1 and SW2 are in Position A. The comparator is held in a balanced condition, and the sampling capacitor arrays acquire the differential signal on the input.

Figure 54. ADC Acquisition Phase

When the ADC starts a conversion, as shown i[n Figure 55,](#page-48-7) SW3 opens, and then SW1 and SW2 move to Position B. This causes the comparator to become unbalanced. Both inputs are disconnected once the conversion begins. The control logic and the charge redistribution DACs are used to add and subtract fixed amounts of charge from the sampling capacitor arrays to bring the comparator back into a balanced condition. When the comparator is rebalanced, the conversion is complete. The control logic generates the ADC output code. The output impedances of the sources driving the V_{IN+} and V_{IN-} input voltage pins must be matched; otherwise, the two inputs have different settling times, resulting in errors.

Figure 55. ADC Conversion Phase

Pseudo Differential Mode

In pseudo differential mode, Channel− is linked to the VIN− pin of the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29.](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) SW2 switches between A (Channel–) and B (V_{REF}). The V_{IN−} pin must be connected to ground or a low voltage. The input signal on $V_{\text{IN+}}$ can then vary from V_{IN}− to V_{REF} + V_{IN}−. Note that V_{IN}− must be chosen so that $V_{REF} + V_{IN-}$ does not exceed AV_{DD}.

Figure 56. ADC in Pseudo Differential Mode

Single-Ended Mode

In single-ended mode, SW2 is always connected internally to ground. The V_{IN} - pin can be floating. The input signal range on V_{IN+} is 0 V to V_{REF} .

Figure 57. ADC in Single-Ended Mode

Analog Input Structure

[Figure 58 s](#page-49-1)hows the equivalent circuit of the analog input structure of the ADC. The four diodes provide ESD protection for the analog inputs. Care must be taken to ensure that the analog input signals never exceed the supply rails by more than 300 mV; exceeding 300 mV causes these diodes to become forwardbiased and start conducting into the substrate. These diodes can conduct up to 10 mA without causing irreversible damage to the part.

The C1 capacitors i[n Figure 58](#page-49-1) are typically 4 pF and can be primarily attributed to pin capacitance. The resistors are lumped components made up of the on resistance of the switches. The value of these resistors is typically about 100 $Ω$. The C2 capacitors are the ADC's sampling capacitors and typically have a capacitance of 16 pF.

Figure 58. Equivalent Analog Input Circuit Conversion Phase: Switches Open, Track Phase: Switches Closed

For ac applications, removing high frequency components from the analog input signal is recommended by using an RC lowpass filter on the relevant analog input pins. In applications where harmonic distortion and signal-to-noise ratio are critical, the analog input should be driven from a low impedance source. Large source impedances significantly affect the ac performance of the ADC. This can necessitate the use of an input buffer amplifier. The choice of the op amp is a function of the particular application[. Figure 59](#page-49-2) an[d Figure 60](#page-49-3) give an example of an ADC front end.

Figure 59. Buffering Single-Ended/Pseudo Differential Input

Figure 60. Buffering Differential Inputs

When no amplifier is used to drive the analog input, the source impedance should be limited to values lower than 1 kΩ. The maximum source impedance depends on the amount of total harmonic distortion (THD) that can be tolerated. The THD increases as the source impedance increases and the performance degrades.

DRIVING THE ANALOG INPUTS

Internal or external references can be used for the ADC. In the differential mode of operation, there are restrictions on the common-mode input signal (V_{CM}) , which is dependent upon the reference value and supply voltage used to ensure that the signal remains within the supply rails[. Table 28](#page-50-2) gives some calculated V_{CM} minimum and V_{CM} maximum values.

04955-020

Table 28. V_{CM} Ranges

CALIBRATION

By default, the factory-set values written to the ADC offset (ADCOF) and gain coefficient registers (ADCGN) yield optimum performance in terms of end-point errors and linearity for standalone operation of the part (see the [Specifications](#page-10-0) section). If system calibration is required, it is possible to modify the default offset and gain coefficients to improve end-point errors, but note that any modification to the factory-set ADCOF and ADCGN values can degrade ADC linearity performance.

For system offset error correction, the ADC channel input stage must be tied to AGND. A continuous software ADC conversion loop must be implemented by modifying the value in ADCOF until the ADC result (ADCDAT) reads Code 0 to Code 1. If the ADCDAT value is greater than 1, ADCOF should be decremented until ADCDAT reads 0 to 1. Offset error correction is done digitally and has a resolution of 0.25 LSB and a range of \pm 3.125% of V_{REF}.

For system gain error correction, the ADC channel input stage must be tied to VREF. A continuous software ADC conversion loop must be implemented to modify the value in ADCGN until the ADC result (ADCDAT) reads Code 4094 to Code 4095. If the ADCDAT value is less than 4094, ADCGN should be incremented until ADCDAT reads 4094 to 4095. Similar to the offset calibration, the gain calibration resolution is 0.25 LSB with a range of $\pm 3\%$ of V_{REF} .

TEMPERATURE SENSOR

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) provide voltage output from on-chip band gap references proportional to absolute temperature. This voltage output can also be routed through the front-end ADC multiplexer (effectively an additional ADC channel input) facilitating an internal temperature sensor channel, measuring die temperature to an accuracy of ±3°C.

The following is an example routine showing how to use the internal temperature sensor:

```
int main(void)
{ 
float a = 0;
     short b;
     ADCCON = 0x20; // power-on the ADC
     delay(2000);
```
Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

```
ADCCP = 0x10; // Select Temperature 
Sensor as an // input to the ADC
     REFCON = 0x01; // connect internal 2.5V 
reference // to Vref pin
     ADCCON = 0xE4; // continuous conversion
     while(1)
      {
              while (|\text{ADCSTA}\rangle)|;// wait for end of conversion
              b = (ADCDAT >> 16);
     // To calculate temperature in °C, use 
the formula:
              a = 0x525 - bi// ((Temperature = 0x525 - Sensor 
Voltage) / 1.3)
              a / = 1.3;
              b = \text{floor}(a);
              printf("Temperature: %d 
oC\ n", b);
```
}

return 0;

```
}
```
BAND GAP REFERENCE

Each [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) provides an onchip band gap reference of 2.5 V, which can be used for the ADC and DAC. This internal reference also appears on the V_{REF} pin. When using the internal reference, a 0.47 μ F capacitor must be connected from the external V_{REF} pin to AGND to ensure stability and fast response during ADC conversions. This reference can also be connected to an external pin (V_{REF}) and used as a reference for other circuits in the system. An external buffer is required because of the low drive capability of the V_{REF} output. A programmable option also allows an external reference input on the V_{REF} pin. Note that it is not possible to disable the internal reference. Therefore, the external reference source must be capable of overdriving the internal reference source.

Table 29. REFCON Register

The band gap reference interface consists of an 8-bit MMR REFCON, described in [Table 30.](#page-50-3)

NONVOLATILE FLASH/EE MEMORY

Th[e ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 i](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ncorporate Flash/EE memory technology on-chip to provide the user with nonvolatile, in-circuit reprogrammable memory space.

Like EEPROM, flash memory can be programmed in-system at a byte level, although it must first be erased. The erase is performed in page blocks. As a result, flash memory is often and more correctly referred to as Flash/EE memory.

Overall, Flash/EE memory represents a step closer to the ideal memory device that includes nonvolatility, in-circuit programmability, high density, and low cost. Incorporated in th[e ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29,](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) Flash/EE memory technology allows the user to update program code space incircuit, without the need to replace one-time programmable (OTP) devices at remote operating nodes.

Each part contains a 64 kB array of Flash/EE memory. The lower 62 kB is available to the user and the upper 2 kB contain permanently embedded firmware, allowing in-circuit serial download. These 2 kB of embedded firmware also contain a power-on configuration routine that downloads factorycalibrated coefficients to the various calibrated peripherals (such as ADC, temperature sensor, and band gap references). This 2 kB embedded firmware is hidden from user code.

Flash/EE Memory Reliability

The Flash/EE memory arrays on the parts are fully qualified for two key Flash/EE memory characteristics: Flash/EE memory cycling endurance and Flash/EE memory data retention.

Endurance quantifies the ability of the Flash/EE memory to be cycled through many program, read, and erase cycles. A single endurance cycle is composed of four independent, sequential events, defined as

- 1. Initial page erase sequence
- 2. Read/verify sequence (single Flash/EE)
- 3. Byte program sequence memory
- 4. Second read/verify sequence (endurance cycle)

In reliability qualification, every half word (16-bit wide) location of the three pages (top, middle, and bottom) in the Flash/EE memory is cycled 10,000 times from 0x0000 to 0xFFFF. As indicated in [Table 1,](#page-10-1) the Flash/EE memory endurance qualification is carried out in accordance with JEDEC Retention Lifetime Specification A117 over the industrial temperature range of −40° to +125°C. The results allow the specification of a minimum endurance figure over a supply temperature of 10,000 cycles.

Retention quantifies the ability of the Flash/EE memory to retain its programmed data over time. Again, the parts are qualified in accordance with the formal JEDEC Retention Lifetime Specification (A117) at a specific junction temperature $(T_J = 85^oC)$. As part of this qualification procedure, the Flash/EE memory is cycled to its specified endurance limit, described in [Table 1,](#page-10-1) before data retention is characterized. This means that the Flash/EE memory is guaranteed to retain its data for its fully specified retention lifetime every time the Flash/EE memory is reprogrammed. In addition, note that retention lifetime, based on an activation energy of 0.6 eV, derates with T_J as shown i[n Figure 61.](#page-51-0)

Figure 61. Flash/EE Memory Data Retention

PROGRAMMING

The 62 kB of Flash/EE memory can be programmed in-circuit, using the serial download mode or the provided JTAG mode.

Serial Downloading (In-Circuit Programming)

Th[e ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 f](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)acilitate code download via the standard UART serial port or via the $I²C$ port. The parts enter serial download mode after a reset or power cycle if the BM pin is pulled low through an external $1 \text{ k}\Omega$ resistor. After a part is in serial download mode, the user can download code to the full 62 kB of Flash/EE memory while the device is in-circuit in its target application hardware. An executable PC serial download is provided as part of the development system for serial downloading via the UART. The [AN-806 Application Note](http://www.analog.com/AN-806) describes the protocol for serial downloading via the I²C.

JTAG Access

The JTAG protocol uses the on-chip JTAG interface to facilitate code download and debug.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

SECURITY

The 62 kB of Flash/EE memory available to the user can be read and write protected.

Bit 31 of the FEEPRO/FEEHIDE MMR (se[e Table 42\)](#page-53-6) protects the 62 kB from being read through JTAG programming mode. The other 31 bits of this register protect writing to the flash memory. Each bit protects four pages, that is, 2 kB. Write protection is activated for all types of access.

Three Levels of Protection

- Protection can be set and removed by writing directly into FEEHIDE MMR. This protection does not remain after reset.
- Protection can be set by writing into the FEEPRO MMR. It takes effect only after a save protection command (0x0C) and a reset. The FEEPRO MMR is protected by a key to avoid direct access. The key is saved once and must be entered again to modify FEEPRO. A mass erase sets the key back to 0xFFFF but also erases all the user code.
- Flash can be permanently protected by using the FEEPRO MMR and a particular value of key: 0xDEADDEAD. Entering the key again to modify the FEEPRO register is not allowed.

Sequence to Write the Key

- 1. Write the bit in FEEPRO corresponding to the page to be protected.
- 2. Enable key protection by setting Bit 6 of FEEMOD (Bit 5 must equal 0).
- 3. Write a 32-bit key in FEEADR and FEEDAT.
- 4. Run the write key command 0x0C in FEECON; wait for the read to be successful by monitoring FEESTA.
- 5. Reset the part.

To remove or modify the protection, the same sequence is used with a modified value of FEEPRO. If the key chosen is the value 0xDEAD, the memory protection cannot be removed. Only a mass erase unprotects the part, but it also erases all user code.

The sequence to write the key is illustrated in the following example (this protects writing Page 4 to Page 7 of the Flash):

The same sequence should be followed to protect the part permanently with $FEEADR = 0xDEAD$ and $FEEDATA = 0xDEAD$.

FLASH/EE CONTROL INTERFACE

Serial and JTAG programming use the Flash/EE control interface, which includes the eight MMRs outlined in this section.

Table 31. FEESTA Register

FEESTA is a read-only register that reflects the status of the flash control interface as described i[n Table 32.](#page-52-2)

Table 32. FEESTA MMR Bit Designations

Table 33. FEEMOD Register

FEEMOD sets the operating mode of the flash control interface. [Table 34](#page-52-3) shows FEEMOD MMR bit designations.

Table 34. FEEMOD MMR Bit Designations

Table 35. FEECON Register

FEECON is an 8-bit command register. The commands are described in [Table 36](#page-53-7)**.**

Table 36. Command Codes in FEECON

¹ The FEECON register always reads 0x07 immediately after execution of any of these commands.

Table 37. FEEDAT Register

FEEDAT is a 16-bit data register.

Table 38. FEEADR Register

FEEADR is another 16-bit address register.

Table 39. FEESIGN Register

FEESIGN is a 24-bit code signature.

Table 40. FEEPRO Register

FEEPRO MMR provides protection following a subsequent reset of the MMR. It requires a software key (see [Table 42\)](#page-53-6).

Table 41. FEEHIDE Register

FEEHIDE MMR provides immediate protection. It does not require any software key. Note that the protection settings in FEEHIDE are cleared by a reset (se[e Table 42\)](#page-53-6).

Table 42. FEEPRO and FEEHIDE MMR Bit Designations

Command Sequence for Executing a Mass Erase

EXECUTION TIME FROM SRAM AND FLASH/EE

Execution from SRAM

Fetching instructions from SRAM takes one clock cycle; the access time of the SRAM is 2 ns, and a clock cycle is 22 ns minimum. However, if the instruction involves reading or writing data to memory, one extra cycle must be added if the data is in SRAM (or three cycles if the data is in Flash/EE): one cycle to execute the instruction, and two cycles to get the 32-bit data from Flash/EE. A control flow instruction (a branch instruction, for example) takes one cycle to fetch but also takes two cycles to fill the pipeline with the new instructions.

Execution from Flash/EE

Because the Flash/EE width is 16 bits and access time for 16-bit words is 22 ns, execution from Flash/EE cannot be done in one cycle (as can be done from SRAM when the CD Bit = 0). Also, some dead times are needed before accessing data for any value of the CD bit.

In ARM mode, where instructions are 32 bits, two cycles are needed to fetch any instruction when $CD = 0$. In thumb mode, where instructions are 16 bits, one cycle is needed to fetch any instruction.

Timing is identical in both modes when executing instructions that involve using the Flash/EE for data memory. If the instruction to be executed is a control flow instruction, an extra cycle is needed to decode the new address of the program counter, and then four cycles are needed to fill the pipeline. A data-processing instruction involving only the core register does not require any extra clock cycles. However, if it involves data in Flash/EE, an extra clock cycle is needed to decode the address of the data, and two cycles are needed to get the 32-bit data from Flash/EE. An extra cycle must also be added before fetching another instruction. Data transfer instructions are more complex and are summarized in [Table 43.](#page-54-1)

Table 43. Execution Cycles in ARM/Thumb Mode

¹ The SWAP instruction combines an LD and STR instruction with only one fetch, giving a total of eight cycles + 40 ns.

²N is the amount of data to load or store in the multiple load/store instruction $(1 < N \le 16)$.

RESET AND REMAP

The ARM exception vectors are all situated at the bottom of the memory array, from Address 0x00000000 to Address 0x00000020, as shown i[n Figure 62.](#page-54-2)

Figure 62. Remap for Exception Execution

By default, and after any reset, the Flash/EE is mirrored at the bottom of the memory array. The remap function allows the programmer to mirror the SRAM at the bottom of the memory array, which facilitates execution of exception routines from SRAM instead of from Flash/EE. This means exceptions are executed twice as fast, being executed in 32-bit ARM mode with 32-bit wide SRAM instead of 16-bit wide Flash/EE memory.

Remap Operation

When a reset occurs on the ADuC7019/20/21/22/24/25/26/27/ 28/29, execution automatically starts in the factory-programmed, internal configuration code. This kernel is hidden and cannot be accessed by user code. If the part is in normal mode (the BM pin is high), it executes the power-on configuration routine of the kernel and then jumps to the reset vector address, 0x00000000, to execute the user's reset exception routine.

Because the Flash/EE is mirrored at the bottom of the memory array at reset, the reset interrupt routine must always be written in Flash/EE.

The remap is done from Flash/EE by setting Bit 0 of the REMAP register. Caution must be taken to execute this command from Flash/EE, above Address 0x00080020, and not from the bottom of the array because this is replaced by the SRAM.

This operation is reversible. The Flash/EE can be remapped at Address 0x00000000 by clearing Bit 0 of the REMAP MMR. Caution must again be taken to execute the remap function from outside the mirrored area. Any type of reset remaps the Flash/EE memory at the bottom of the array.

Reset Operation

There are four kinds of reset: external, power-on, watchdog expiration, and software force. The RSTSTA register indicates the source of the last reset, and RSTCLR allows clearing of the RSTSTA register. These registers can be used during a reset exception service routine to identify the source of the reset. If RSTSTA is null, the reset is external.

Table 44. REMAP Register

¹ Depends on the model.

Table 45. REMAP MMR Bit Designations

Table 46. RSTSTA Register

Table 47. RSTSTA MMR Bit Designations

Table 48. RSTCLR Register

Note that to clear the RSTSTA register, the user must write 0x07 to the RSTCLR register.

OTHER ANALOG PERIPHERALS

DAC

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 i](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ncorporate two, three, or four 12-bit voltage output DACs on-chip, depending on the model. Each DAC has a rail-to-rail voltage output buffer capable of driving 5 kΩ/100 pF.

Each DAC has three selectable ranges: 0 V to V_{REF} (internal band gap 2.5 V reference), 0 V to DACREF, and 0 V to AV_{DD}. DAC_{REF} is equivalent to an external reference for the DAC. The signal range is 0 V to AV_{DD} .

MMRs Interface

Each DAC is independently configurable through a control register and a data register. These two registers are identical for the four DACs. Only DAC0CON (see [Table 50\)](#page-56-2) and DAC0DAT (see [Table 52\)](#page-56-3) are described in detail in this section.

Table 49. DACxCON Registers

Table 50. DAC0CON MMR Bit Designations

Table 51. DACxDAT Registers

Table 52. DAC0DAT MMR Bit Designations

Using the DACs

The on-chip DAC architecture consists of a resistor string DAC followed by an output buffer amplifier. The functional equivalent is shown i[n Figure 63.](#page-56-4)

Figure 63. DAC Structure

As illustrated i[n Figure 63,](#page-56-4) the reference source for each DAC is user-selectable in software. It can be AV_{DD}, V_{REF}, or DAC_{REF}. In 0-to-AV_{DD} mode, the DAC output transfer function spans from 0 V to the voltage at the AV_{DD} pin. In 0-to-DAC_{REF} mode, the DAC output transfer function spans from 0 V to the voltage at the DACREF pin. In 0-to-VREF mode, the DAC output transfer function spans from 0 V to the internal 2.5 V reference, V_{REF} .

The DAC output buffer amplifier features a true, rail-to-rail output stage implementation. This means that when unloaded, each output is capable of swinging to within less than 5 mV of both AV_{DD} and ground. Moreover, the DAC's linearity specification (when driving a 5 k Ω resistive load to ground) is guaranteed through the full transfer function, except Code 0 to Code 100, and, in 0-to-AV_{DD} mode only, Code 3995 to Code 4095.

Linearity degradation near ground and AV_{DD} is caused by saturation of the output amplifier, and a general representation of its effects (neglecting offset and gain error) is illustrated i[n Figure 64.](#page-57-1) The dotted line i[n Figure 64 i](#page-57-1)ndicates the ideal transfer function, and the solid line represents what the transfer function may look like with endpoint nonlinearities due to saturation of the output amplifier. Note tha[t Figure 64 r](#page-57-1)epresents a transfer function in 0-to-AV $_{\rm DD}$ mode only. In 0-to-VREF or 0-to-DACREF mode (with V_{REF} < AV_{DD} or DAC_{REF} < AV_{DD}), the lower nonlinearity is similar. However, the upper portion of the transfer function follows the ideal line right to the end (V_{REF} in this case, not AV_{DD}), showing no signs of endpoint linearity errors.

Figure 64. Endpoint Nonlinearities Due to Amplifier Saturation

04955-024

The endpoint nonlinearities conceptually illustrated in [Figure 64 g](#page-57-1)et worse as a function of output loading. Most of the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 d](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ata sheet specifications assume a 5 k Ω resistive load to ground at the DAC output. As the output is forced to source or sink more current, the nonlinear regions at the top or bottom (respectively) o[f Figure 64 b](#page-57-1)ecome larger. With larger current demands, this can significantly limit output voltage swing.

POWER SUPPLY MONITOR

The power supply monitor regulates the IOV_DD supply on the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29.](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) It indicates when the IOV_{DD} supply pin drops below one of two supply trip points. The monitor function is controlled via the PSMCON register. If enabled in the IRQEN or FIQEN register, the monitor interrupts the core using the PSMI bit in the PSMCON MMR. This bit is immediately cleared after CMP goes high.

This monitor function allows the user to save working registers to avoid possible data loss due to low supply or brown-out conditions. It also ensures that normal code execution does not resume until a safe supply level is established.

Table 54. PSMCON MMR Bit Descriptions

COMPARATOR

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 i](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ntegrate voltage comparators. The positive input is multiplexed with ADC2, and the negative input has two options: ADC3 and DAC0. The output of the comparator can be configured to generate a system interrupt, be routed directly to the programmable logic array, start an ADC conversion, or be on an external pin, CMP_{OUT} , as shown in [Figure 65.](#page-57-2)

Note that because the ADuC7022, ADuC7025, and ADu7027 parts do not support a DAC0 output, it is not possible to use DAC0 as a comparator input on these parts.

Hysteresis

[Figure 66 s](#page-57-3)hows how the input offset voltage and hysteresis terms are defined.

Figure 66. Comparator Hysteresis Transfer Function

Input offset voltage (V_{OS}) is the difference between the center of the hysteresis range and the ground level. This can either be positive or negative. The hysteresis voltage (V_H) is one-half the width of the hysteresis range.

Comparator Interface

The comparator interface consists of a 16-bit MMR, CMPCON, which is described i[n Table 56.](#page-58-1)

Table 55. CMPCON Register

OSCILLATOR AND PLL—POWER CONTROL *Clocking System*

Eac[h ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) integrates a

32.768 kHz ±3% oscillator, a clock divider, and a PLL. The PLL locks onto a multiple (1275) of the internal oscillator or an external 32.768 kHz crystal to provide a stable 41.78 MHz clock (UCLK) for the system. To allow power saving, the core can operate at this frequency, or at binary submultiples of it. The actual core operating frequency, UCLK/2CD, is refered to as HCLK. The default core clock is the PLL clock divided by 8 (CD = 3) or 5.22 MHz. The core clock frequency can also come from an external clock on the ECLK pin as described in [Figure 67.](#page-58-2) The core clock can be outputted on ECLK when using an internal oscillator or external crystal.

Note that when the ECLK pin is used to output the core clock, the output signal is not buffered and is not suitable for use as a clock source to an external device without an external buffer.

The selection of the clock source is in the PLLCON register. By default, the part uses the internal oscillator feeding the PLL.

External Crystal Selection

To switch to an external crystal, the user must do the following:

- 1. Enable the Timer2 interrupt and configure it for a timeout period of >120 µs.
- 2. Follow the write sequence to the PLLCON register, setting the MDCLK bits to 01 and clearing the OSEL bit.
- 3. Force the part into NAP mode by following the correct write sequence to the POWCON register.

When the part is interrupted from NAP mode by the Timer2 interrupt source, the clock source has switched to the external clock.

Example source code

```
 t2val_old= T2VAL; 
      T2LD = 5; 
     TCON = 0x480;while ((T2VAL = t2val_old) || (T2VAL)3)) //ensures timer value loaded 
  IRQEN = 0x10;//enable T2 interrupt 
   PLLKEY1 = 0xAA; 
 PLLCON = 0 \times 01;
 PLLKEY2 = 0x55;
 POWKEY1 = 0x01;POWCON = 0x27;// Set Core into Nap mode 
  POWKEY2 = 0xF4;
```
In noisy environments, noise can couple to the external crystal pins, and PLL may lose lock momentarily. A PLL interrupt is provided in the interrupt controller. The core clock is immediately halted, and this interrupt is only serviced when the lock is restored.

In case of crystal loss, the watchdog timer should be used. During initialization, a test on the RSTSTA register can determine if the reset came from the watchdog timer.

External Clock Selection

To switch to an external clock on P0.7, configure P0.7 in Mode 1. The external clock can be up to 44 MHz, providing the tolerance is 1%.

Example source code

```
 t2val_old= T2VAL; 
    T2LD = 5;TCON = 0x480;while ((T2VAL = t2val_old) || (T2VAL)> 3)) //ensures timer value loaded
  IRQEN = 0x10;//enable T2 interrupt
  PLLKEY1 = 0xAA;
   PLLCON = 0x03; //Select external clock 
  PLLKEY2 = 0x55;
  POWKEY1 = 0x01;POWCON = 0x27;
```

```
// Set Core into Nap mode 
  POWKEY2 = 0xF4;
```
Power Control System

A choice of operating modes is available on the ADuC7019/20/ 21/22/24/25/26/27/28/29[. Table 57](#page-59-0) describes what part is powered on in the different modes and indicates the power-up time.

[Table 58](#page-59-1) gives some typical values of the total current consumption (analog + digital supply currents) in the different modes, depending on the clock divider bits. The ADC is turned off. Note that these values also include current consumption of the regulator and other parts on the test board where these values are measured.

¹ X indicates that the part is powered on.

Table 58. Typical Current Consumption at 25°C in Milliamperes

MMRs and Keys

The operating mode, clocking mode, and programmable clock divider are controlled via two MMRs: PLLCON (se[e Table 61\)](#page-60-4) and POWCON (se[e Table 64\)](#page-60-5). PLLCON controls the operating mode of the clock system, whereas POWCON controls the core clock frequency and the power-down mode.

To prevent accidental programming, a certain sequence (see [Table 65\)](#page-60-6) must be followed to write to the PLLCON and POWCON registers.

Table 59. PLLKEYx Registers

Table 60. PLLCON Register

Table 61. PLLCON MMR Bit Designations

Table 62. POWKEYx Registers

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 63. POWCON Register

Table 64. POWCON MMR Bit Designations

Table 65. PLLCON and POWCON Write Sequence

DIGITAL PERIPHERALS

3-PHASE PWM

Each [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) provides a flexible and programmable, 3-phase pulse-width modulation (PWM) waveform generator. It can be programmed to generate the required switching patterns to drive a 3-phase voltage source inverter for ac induction motor control (ACIM). Note that only active high patterns can be produced.

The PWM generator produces three pairs of PWM signals on the six PWM output pins (PWM0 $_{\rm H}$, PWM0 $_{\rm L}$, PWM1 $_{\rm H}$, PWM1 $_{\rm L}$, PWM2H, and PWM2L). The six PWM output signals consist of three high-side drive signals and three low-side drive signals.

The switching frequency and dead time of the generated PWM patterns are programmable using the PWMDAT0 and PWMDAT1 MMRs. In addition, three duty-cycle control registers (PWMCH0, PWMCH1, and PWMCH2) directly control the duty cycles of the three pairs of PWM signals.

Each of the six PWM output signals can be enabled or disabled by separate output enable bits of the PWMEN register. In addition, three control bits of the PWMEN register permit crossover of the two signals of a PWM pair. In crossover mode, the PWM signal destined for the high-side switch is diverted to the complementary low-side output. The signal destined for the low-side switch is diverted to the corresponding high-side output signal.

In many applications, there is a need to provide an isolation barrier in the gate-drive circuits that turn on the inverter power devices. In general, there are two common isolation techniques: optical isolation using optocouplers and transformer isolation using pulse transformers. The PWM controller permits mixing of the output PWM signals with a high frequency chopping signal to permit easy interface to such pulse transformers. The features of this gate-drive chopping mode can be controlled by the PWMCFG register. An 8-bit value within the PWMCFG register directly controls the chopping frequency. High frequency chopping can be independently enabled for the highside and low-side outputs using separate control bits in the PWMCFG register.

The PWM generator can operate in one of two distinct modes: single update mode or double update mode. In single update mode, the duty cycle values are programmable only once per PWM period so that the resulting PWM patterns are symmetrical about the midpoint of the PWM period. In the double update mode, a second updating of the PWM duty cycle values is implemented at the midpoint of the PWM period.

In double update mode, it is also possible to produce asymmetrical PWM patterns that produce lower harmonic distortion in 3-phase PWM inverters. This technique permits closed-loop controllers to change the average voltage applied to the machine windings at a faster rate. As a result, faster closed-loop bandwidths are achieved. The operating mode of the PWM block is selected by a control bit in the PWMCON register. In single update mode,

an internal synchronization pulse, PWMSYNC, is produced at the start of each PWM period. In double update mode, an additional PWMSYNC pulse is produced at the midpoint of each PWM period.

The PWM block can also provide an internal synchronization pulse on the PWM_{SYNC} pin that is synchronized to the PWM switching frequency. In single update mode, a pulse is produced at the start of each PWM period. In double update mode, an additional pulse is produced at the mid-point of each PWM period. The width of the pulse is programmable through the PWMDAT2 register. The PWM block can also accept an external synchronization pulse on the PWMSYNC pin. The selection of external synchronization or internal synchronization is in the PWMCON register. The SYNC input timing can be synchronized to the internal peripheral clock, which is selected in the PWMCON register. If the external synchronization pulse from the chip pin is asynchronous to the internal peripheral clock (typical case), the external PWMSYNC is considered asynchronous and should be synchronized. The synchronization logic adds latency and jitter from the external pulse to the actual PWM outputs. The size of the pulse on the PWMSYNC pin must be greater than two core clock periods.

The PWM signals produced by the ADuC7019/20/21/22/24/25/ 26/27/28/29 can be shut off via a dedicated asynchronous PWM shutdown pin, PWMTRIP. When brought low, PWMTRIP instantaneously places all six PWM outputs in the off state (high). This hardware shutdown mechanism is asynchronous so that the associated PWM disable circuitry does not go through any clocked logic. This ensures correct PWM shutdown even in the event of a core clock loss.

Status information about the PWM system is available to the user in the PWMSTA register. In particular, the state of the PWMTRIP pin is available, as well as a status bit that indicates whether operation is in the first half or the second half of the PWM period.

40-Pin Package Devices

On the 40-pin package devices, the PWM outputs are not directly accessible, as described in the [General-Purpose](#page-67-6) [Input/Output](#page-67-6) section. One channel can be brought out on a GPIO (se[e Table 78\)](#page-68-0) via the PLA as shown in the following example:

DESCRIPTION OF THE PWM BLOCK

A functional block diagram of the PWM controller is shown in [Figure 68.](#page-62-0) The generation of the six output PWM signals on Pin PWM0_H to Pin PWM2_L is controlled by the following four important blocks:

- The 3-phase PWM timing unit. The core of the PWM controller, this block generates three pairs of complemented and dead-time-adjusted, center-based PWM signals. This unit also generates the internal synchronization pulse, PWMSYNC. It also controls whether the external PWMSYNC pin is used.
- The output control unit. This block can redirect the outputs of the 3-phase timing unit for each channel to either the high-side or low-side output. In addition, the output control unit allows individual enabling/disabling of each of the six PWM output signals.
- The gate drive unit. This block can generate the high frequency chopping and its subsequent mixing with the PWM signals.
- The PWM shutdown controller. This block controls the PWM shutdown via the PWM_{TRIP} pin and generates the correct reset signal for the timing unit.

The PWM controller is driven by the ADuC7019/20/21/22/24/ 25/26/27/28/29 core clock frequency and is capable of generating two interrupts to the ARM core. One interrupt is generated on the occurrence of a PWMSYNC pulse, and the other is generated on the occurrence of any PWM shutdown action.

3-Phase Timing Unit

PWM Switching Frequency (PWMDAT0 MMR)

The PWM switching frequency is controlled by the PWM period register, PWMDAT0. The fundamental timing unit of the PWM controller is

$$
t_{\text{CORE}} = 1/f_{\text{CORE}}
$$

where *fcoRE* is the core frequency of the MicroConverter.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Therefore, for a 41.78 MHz f_{CORE}, the fundamental time increment is 24 ns. The value written to the PWMDAT0 register is effectively the number of f_{CORE} clock increments in one-half a PWM period. The required PWMDAT0 value is a function of the desired PWM switching frequency (f_{PWN}) and is given by

$PWMDAT0 = f_{CORE}/(2 \times f_{PWM})$

Therefore, the PWM switching period, ts, can be written as

 $t_S = 2 \times PWMDATA \times t_{CORE}$

The largest value that can be written to the 16-bit PWMDAT0 MMR is $0x$ FFFF = 65,535, which corresponds to a minimum PWM switching frequency of

 $f_{\text{PWM}(min)} = 41.78 \times 10^6 / (2 \times 65{,}535) = 318.75 \text{ Hz}$

Note that PWMDAT0 values of 0 and 1 are not defined and should not be used.

PWM Switching Dead Time (PWMDAT1 MMR)

The second important parameter that must be set up in the initial configuration of the PWM block is the switching dead time. This is a short delay time introduced between turning off one PWM signal (0H, for example) and turning on the complementary signal (0L). This short time delay is introduced to permit the power switch to be turned off (in this case, 0H) to completely recover its blocking capability before the complementary switch is turned on. This time delay prevents a potentially destructive short-circuit condition from developing across the dc link capacitor of a typical voltage source inverter.

The dead time is controlled by the 10-bit, read/write PWMDAT1 register. There is only one dead-time register that controls the dead time inserted into all three pairs of PWM output signals. The dead time, t_D , is related to the value in the PWMDAT1 register by

$t_D = PWMDATA \times 2 \times t_{CORE}$

Therefore, a PWMDAT1 value of $0x00A (= 10)$, introduces a 426 ns delay between the turn-off on any PWM signal (0H, for example) and the turn-on of its complementary signal (0L). The amount of the dead time can, therefore, be programmed in increments of $2t_{\text{CORE}}$ (or 49 ns for a 41.78 MHz core clock).

Figure 68. Overview of the PWM Controller

The PWMDAT1 register is a 10-bit register with a maximum value of $0x3FF (= 1023)$, which corresponds to a maximum programmed dead time of

 $t_{D(max)} = 1023 \times 2 \times t_{CORE} = 1023 \times 2 \times 24 \times 10^{-9} = 48.97 \text{ }\mu\text{s}$

for a core clock of 41.78 MHz.

The dead time can be programmed to be zero by writing 0 to the PWMDAT1 register.

PWM Operating Mode (PWMCON and PWMSTA MMRs)

As discussed in th[e 3-Phase PWM](#page-61-0) section, the PWM controller of the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 c](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)an operate in two distinct modes: single update mode and double update mode. The operating mode of the PWM controller is determined by the state of Bit 2 of the PWMCON register. If this bit is cleared, the PWM operates in the single update mode. Setting Bit 2 places the PWM in the double update mode. The default operating mode is single update mode.

In single update mode, a single PWMSYNC pulse is produced in each PWM period. The rising edge of this signal marks the start of a new PWM cycle and is used to latch new values from the PWM configuration registers (PWMDAT0 and PWMDAT1) and the PWM duty cycle registers (PWMCH0, PWMCH1, and PWMCH2) into the 3-phase timing unit. In addition, the PWMEN register is latched into the output control unit on the rising edge of the PWMSYNC pulse. In effect, this means that the characteristics and resulting duty cycles of the PWM signals can be updated only once per PWM period at the start of each cycle. The result is symmetrical PWM patterns about the midpoint of the switching period.

In double update mode, there is an additional PWMSYNC pulse produced at the midpoint of each PWM period. The rising edge of this new PWMSYNC pulse is again used to latch new values of the PWM configuration registers, duty cycle registers, and the PWMEN register. As a result, it is possible to alter both the characteristics (switching frequency and dead time) as well as the output duty cycles at the midpoint of each PWM cycle. Consequently, it is also possible to produce PWM switching patterns that are no longer symmetrical about the midpoint of the period (asymmetrical PWM patterns). In double update mode, it could be necessary to know whether operation at any point in time is in either the first half or the second half of the PWM cycle. This information is provided by Bit 0 of the PWMSTA register, which is cleared during operation in the first half of each PWM period (between the rising edge of the original PWMSYNC pulse and the rising edge of the new PWMSYNC pulse introduced in double update mode). Bit 0 of the PWMSTA register is set during operation in the second half of each PWM period. This status bit allows the user to make a determination of the particular half cycle during implementation of the PWMSYNC interrupt service routine, if required.

The advantage of double update mode is that lower harmonic voltages can be produced by the PWM process, and faster control bandwidths are possible. However, for a given PWM switching frequency, the PWMSYNC pulses occur at twice the rate in the double update mode. Because new duty cycle values must be computed in each PWMSYNC interrupt service routine, there is a larger computational burden on the ARM core in double update mode.

PWM Duty Cycles (PWMCH0, PWMCH1, and PWMCH2 MMRs)

The duty cycles of the six PWM output signals on Pin PWM0H to Pin PWM2L are controlled by the three 16-bit read/write duty cycle registers, PWMCH0, PWMCH1, and PWMCH2. The duty cycle registers are programmed in integer counts of the fundamental time unit, tcore. They define the desired on time of the high-side PWM signal produced by the 3-phase timing unit over half the PWM period. The switching signals produced by the 3-phase timing unit are also adjusted to incorporate the programmed dead time value in the PWMDAT1 register. The 3-phase timing unit produces active high signals so that a high level corresponds to a command to turn on the associated power device.

[Figure 69 s](#page-63-0)hows a typical pair of PWM outputs (in this case, 0H and 0L) from the timing unit in single update mode. All illustrated time values indicate the integer value in the associated register and can be converted to time by simply multiplying by the fundamental time increment, tcore. Note that the switching patterns are perfectly symmetrical about the midpoint of the switching period in this mode because the same values of PWMCH0, PWMDAT0, and PWMDAT1 are used to define the signals in both half cycles of the period.

[Figure 69 a](#page-63-0)lso demonstrates how the programmed duty cycles are adjusted to incorporate the desired dead time into the resulting pair of PWM signals. The dead time is incorporated by moving the switching instants of both PWM signals (0H and 0L) away from the instant set by the PWMCH0 register.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Both switching edges are moved by an equal amount (PWMDAT1 \times tcore) to preserve the symmetrical output patterns.

Also shown are the PWMSYNC pulse and Bit 0 of the PWMSTA register, which indicates whether operation is in the first or second half cycle of the PWM period.

The resulting on times of the PWM signals over the full PWM period (two half periods) produced by the timing unit can be written as follows:

On the high side

 t_{0HH} = $PWMDAT0$ + 2($PWMCH0$ – $PWMDAT1$) \times t_{CORE}

 t_{0HL} = $PWMDATO - 2(PWMCHO - PWMDAT1) \times t_{CORE}$

and the corresponding duty cycles (*d*)

 $d_{0H} = t_{0HH}/t_s = \frac{1}{2} + (PWMCHO - PWMDATI)/PWMDATO$ and on the low side

 t_{0LH} = $PWMDATO - 2(PWMCHO + PWMDAT1) \times t_{CORE}$

 t_{0LL} = $PWMDAT0$ + 2 $(PWMCHO$ + $PWMDAT1$) $\times t_{CORE}$

and the corresponding duty cycles (*d*)

dOL = *t0LH*/*tS* = ½ − (*PWMCH0* + *PWMDAT1*)/*PWMDAT0*

The minimum permissible t_{0H} and t_{0L} values are zero, corresponding to a 0% duty cycle. In a similar fashion, the maximum value is t_s, corresponding to a 100% duty cycle.

[Figure 70 s](#page-64-0)hows the output signals from the timing unit for operation in double update mode. It illustrates a general case where the switching frequency, dead time, and duty cycle are all changed in the second half of the PWM period. The same value for any or all of these quantities can be used in both halves of the PWM cycle. However, there is no guarantee that symmetrical PWM signals are produced by the timing unit in double update mode. [Figure 70 a](#page-64-0)lso shows that the dead time insertions into the PWM signals are done in the same way as in single update mode.

(Double Update Mode)

In general, the on times of the PWM signals in double update mode can be defined as follows:

On the high side

 $t_{0HH} = (PWMDATA_1/2 + PWMDATA_2/2 + PWMCH0_1 +$ $PWMCHO₂ - PWMDAT1₁ - PWMDAT1₂ \times t_{CORE}$

 $t_{0HL} = (PWMDATA_1/2 + PWMDATA_2/2 - PWMCHO_1 PWMCHO₂ + PWMDAT1₁ + PWMDAT1₂ \times t_{CORE}$

where Subscript *1* refers to the value of that register during the first half cycle, and Subscript *2* refers to the value during the second half cycle.

The corresponding duty cycles (*d*) are

 $d_{0H} = t_{0HH}/t_s = (PWMDATA_1/2 + PWMDATA_2/2 + PWMDA_1/2)$ $PWMCHO_1 + PWMCHO_2 - PWMDAT1_1 - PWMDAT1_2$ (*PWMDAT01 + PWMDAT02*)

On the low side

 $t_{0LH} = (PWMDATA_1/2 + PWMDATA_2/2 + PWMCH0_1 +$ $PWMCH0₂ + PWMDAT1₁ + PWMDAT1₂) \times t_{CORE}$

t0LL = (*PWMDAT01*/2 + *PWMDAT02*/2 − *PWMCH01* − $PWMCHO₂ - PWMDAT1₁ - PWMDAT1₂ \times t_{CORE}$

where Subscript *1* refers to the value of that register during the first half cycle, and Subscript *2* refers to the value during the second half cycle.

The corresponding duty cycles (d) are

 $d_{0L} = t_{0LH}/t_s = (PWMDATA_1/2 + PWMDATA_2/2 +$ $PWMCHO_1 + PWMCHO_2 + PWMDA T1_1 +$ *PWMDAT12*)/(*PWMDAT01* + *PWMDAT02*)

For the completely general case in double update mode (see [Figure 70\)](#page-64-0), the switching period is given by

 $t_S = (PWMDATA_1 + PWMDATA_2) \times t_{CORE}$

Again, the values of t_{0H} and t_{0L} are constrained to lie between zero and ts.

PWM signals similar to those illustrated i[n Figure 69](#page-63-0) and [Figure 70 c](#page-64-0)an be produced on the 1H, 1L, 2H, and 2L outputs by programming the PWMCH1 and PWMCH2 registers in a manner identical to that described for PWMCH0. The PWM controller does not produce any PWM outputs until all of the PWMDAT0, PWMCH0, PWMCH1, and PWMCH2 registers have been written to at least once. When these registers are written, internal counting of the timers in the 3-phase timing unit is enabled.

Writing to the PWMDAT0 register starts the internal timing of the main PWM timer. Provided that the PWMDAT0 register is written to prior to the PWMCH0, PWMCH1, and PWMCH2 registers in the initialization, the first PWMSYNC pulse and interrupt (if enabled) appear $1.5 \times t_{\text{CORE}} \times \text{PWMDAT0 seconds}$ after the initial write to the PWMDAT0 register in single update mode. In double update mode, the first PWMSYNC pulse appears after PWMDAT0 \times tcore seconds.

04955-030

Output Control Unit

The operation of the output control unit is controlled by the 9-bit read/write PWMEN register. This register controls two distinct features of the output control unit that are directly useful in the control of electronic counter measures (ECM) or binary decimal counter measures (BDCM). The PWMEN register contains three crossover bits, one for each pair of PWM outputs. Setting Bit 8 of the PWMEN register enables the crossover mode for the 0H/0L pair of PWM signals, setting Bit 7 enables crossover on the 1H/1L pair of PWM signals, and setting Bit 6 enables crossover on the 2H/2L pair of PWM signals. If crossover mode is enabled for any pair of PWM signals, the high-side PWM signal from the timing unit (0H, for example) is diverted to the associated low-side output of the output control unit so that the signal ultimately appears at the PWM0L pin. Of course, the corresponding low-side output of the timing unit is also diverted to the complementary high-side output of the output control unit so that the signal appears at the $PWMO_H$ pin. Following a reset, the three crossover bits are cleared, and the crossover mode is disabled on all three pairs of PWM signals. The PWMEN register also contains six bits (Bit 0 to Bit 5) that can be used to individually enable or disable each of the six PWM outputs. If the associated bit of the PWMEN register is set, the corresponding PWM output is disabled regardless of the corresponding value of the duty cycle register. This PWM output signal remains in the off state as long as the corresponding enable/disable bit of the PWMEN register is set. The implementation of this output enable function is implemented after the crossover function.

Following a reset, all six enable bits of the PWMEN register are cleared, and all PWM outputs are enabled by default. In a manner identical to the duty cycle registers, the PWMEN is latched on the rising edge of the PWMSYNC signal. As a result, changes to this register become effective only at the start of each PWM cycle in single update mode. In double update mode, the PWMEN register can also be updated at the midpoint of the PWM cycle.

In the control of an ECM, only two inverter legs are switched at any time, and often the high-side device in one leg must be switched on at the same time as the low-side driver in a second leg. Therefore, by programming identical duty cycle values for two PWM channels (for example, PWMCH0 = PWMCH1) and setting Bit 7 of the PWMEN register to cross over the 1H/1L pair of PWM signals, it is possible to turn on the high-side switch of Phase A and the low-side switch of Phase B at the same time. In the control of ECM, it is usual for the third inverter leg (Phase C in this example) to be disabled for a number of PWM cycles. This function is implemented by disabling both the 2H and 2L PWM outputs by setting Bit 0 and Bit 1 of the PWMEN register.

This situation is illustrated i[n Figure 71,](#page-65-0) where it can be seen that both the 0H and 1L signals are identical because PWMCH0 = PWMCH1 and the crossover bit for Phase B is set.

PWMCH0 = PWMCH1, Crossover 1H/1L Pair and Disable 0L, 1H, 2H, and 2L Outputs in Single Update Mode.

In addition, the other four signals (0L, 1H, 2H, and 2L) have been disabled by setting the appropriate enable/disable bits of the PWMEN register. I[n Figure 71,](#page-65-0) the appropriate value for the PWMEN register is 0x00A7. In normal ECM operation, each inverter leg is disabled for certain periods of time to change the PWMEN register based on the position of the rotor shaft (motor commutation).

Gate Drive Unit

The gate drive unit of the PWM controller adds features that simplify the design of isolated gate-drive circuits for PWM inverters. If a transformer-coupled, power device, gate-drive amplifier is used, the active PWM signal must be chopped at a high frequency. The 16-bit read/write PWMCFG register programs this high frequency chopping mode. The chopped active PWM signals can be required for the high-side drivers only, the low-side drivers only, or both the high-side and lowside switches. Therefore, independent control of this mode for both high-side and low-side switches is included with two separate control bits in the PWMCFG register.

Typical PWM output signals with high frequency chopping enabled on both high-side and low-side signals are shown in [Figure 72.](#page-66-2) Chopping of the high-side PWM outputs (0H, 1H, and 2H) is enabled by setting Bit 8 of the PWMCFG register. Chopping of the low-side PWM outputs (0L, 1L, and 2L) is enabled by setting Bit 9 of the PWMCFG register. The high chopping frequency is controlled by the 8-bit word (GDCLK) placed in Bit 0 to Bit 7 of the PWMCFG register. The period of this high frequency carrier is

 $t_{CHOP} = (4 \times (GDCLK + 1)) \times t_{CORE}$

The chopping frequency is, therefore, an integral subdivision of the MicroConverter core frequency

$$
f_{CHOP} = f_{CORE}/(4 \times (GDCLK + 1))
$$

The GDCLK value can range from 0 to 255, corresponding to a programmable chopping frequency rate of 40.8 kHz to 10.44 MHz for a 41.78 MHz core frequency. The gate drive features must be programmed before operation of the PWM controller and are typically not changed during normal operation of the PWM controller. Following a reset, all bits of the PWMCFG register are cleared so that high frequency chopping is disabled, by default.

Figure 72. Typical PWM Signals with High Frequency Gate Chopping Enabled on Both High-Side and Low-Side Switches

PWM Shutdown

In the event of external fault conditions, it is essential that the PWM system be instantaneously shut down in a safe fashion. A low level on the PWM_{TRIP} pin provides an instantaneous, asynchronous (independent of the MicroConverter core clock) shutdown of the PWM controller. All six PWM outputs are placed in the off state, that is, in low state. In addition, the PWMSYNC pulse is disabled. The PWM_TRIP pin has an internal pull-down resistor to disable the PWM if the pin becomes disconnected. The state of the PWMTRIP pin can be read from Bit 3 of the PWMSTA register.

If a PWM shutdown command occurs, a PWMTRIP interrupt is generated, and internal timing of the 3-phase timing unit of the PWM controller is stopped. Following a PWM shutdown, the PWM can be reenabled (in a PWMTRIP interrupt service routine, for example) only by writing to all of the PWMDAT0, PWMCH0, PWMCH1, and PWMCH2 registers. Provided that the external fault is cleared and the PWMTRIP is returned to a high level, the internal timing of the 3-phase timing unit resumes, and new duty-cycle values are latched on the next PWMSYNC boundary.

Note that the PWMTRIP interrupt is available in IRQ only, and the PWMSYNC interrupt is available in FIQ only. Both interrupts share the same bit in the interrupt controller. Therefore, only one of the interrupts can be used at a time. See the [Interrupt System](#page-83-4) section for further details.

PWM MMRs Interface

The PWM block is controlled via the MMRs described in this section.

Table 66. PWMCON Register

PWMCON is a control register that enables the PWM and chooses the update rate.

Table 68. PWMSTA Register

PWMSTA reflects the status of the PWM.

Table 69. PWMSTA MMR Bit Descriptions

Table 70. PWMCFG Register

PWMCFG is a gate chopping register.

Table 71. PWMCFG MMR Bit Descriptions

Table 72. PWMEN Register

PWMEN allows enabling of channel outputs and crossover. See its bit definitions in [Table 73.](#page-67-7)

Table 73. PWMEN MMR Bit Descriptions

Table 74. PWMDAT0 Register

PWMDAT0 is an unsigned 16-bit register for switching period.

Table 75. PWMDAT1 Register

PWMDAT1 is an unsigned 10-bit register for dead time.

Table 76. PWMCHx Registers

PWMCH0, PWMCH1, and PWMCH2 are channel duty cycles for the three phases.

Table 77. PWMDAT2 Register

PWMDAT2 is an unsigned 10-bit register for PWM sync pulse width.

GENERAL-PURPOSE INPUT/OUTPUT

Th[e ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) provide 40 generalpurpose, bidirectional I/O (GPIO) pins. All I/O pins are 5 V tolerant, meaning the GPIOs support an input voltage of 5 V. In general, many of the GPIO pins have multiple functions (see [Table 78](#page-68-0) for the pin function definitions). By default, the GPIO pins are configured in GPIO mode.

All GPIO pins have an internal pull-up resistor (of about 100 kΩ), and their drive capability is 1.6 mA. Note that a maximum of 20 GPIOs can drive 1.6 mA at the same time. Using the GPxPAR registers, it is possible to enable/disable the pull-up resistors for the following ports: P0.0, P0.4, P0.5, P0.6, P0.7, and the eight GPIOs of P1.

The 40 GPIOs are grouped in five ports, Port 0 to Port 4 (Port x). Each port is controlled by four or five MMRs.

Note that the kernel changes P0.6 from its default configuration at reset (MRST) to GPIO mode and P0.6 goes low for the reset period. For example, if MRST is required for power-down, MRST can be reconfigured in the GP0CON MMR.

The input level of any GPIO can be read at any time in the GPxDAT MMR, even when the pin is configured in a mode other than GPIO. The PLA input is always active.

When th[e ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) part enters a power-saving mode, the GPIO pins retain their state.

Table 78. GPIO Pin Function Descriptions

¹ When configured in Mode 1, P0.7 is ECLK by default, or core clock output. To configure it as a clock input, the MDCLK bits in PLLCON must be set to 11. ² The CONV_{START} signal is active in all modes of P2.0.

Table 79. GPxCON Registers

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

GPxCON are the Port x control registers, which select the function of each pin of Port x as described in [Table 80.](#page-68-3)

Table 80. GPxCON MMR Bit Descriptions

Table 81. GPxPAR Registers

GPxPAR program the parameters for Port 0 and Port 1. Note that the GPxDAT MMR must always be written after changing the GPxPAR MMR.

Table 82. GPxPAR MMR Bit Descriptions

Table 83. GPIO Drive Strength Control Bits Descriptions

Table 84. GPxPAR Control Bits Access Descriptions

Bit	GPOPAR	GP1PAR
31	Reserved	Reserved
30 to 29	R/W	R/W
28	R/W	R/W
27	Reserved	Reserved
26 to 25	R/W	R/W
24	R/W	R/W
23	Reserved	Reserved
22 to 21	R/W	R (b00)
20	R/W	R/W
19	Reserved	Reserved
18 to 17	R (b00)	R (b00)
16	R/W	R/W
15	Reserved	Reserved
14 to 13	R (b00)	R (b00)
12	R/W	R/W
11	Reserved	Reserved
10 to 9	R (b00)	R (b00)
8	R/W	R/W
$\overline{7}$	Reserved	Reserved
6 to 5	R (b00)	R (b00)
4	R/W	R/W
3	Reserved	Reserved
2 to 1	R (b00)	R (b00)
0	R/W	R/W

The drive strength bits can be written to one time only after reset. More writing to related bits has no effect on changing drive strength. The GPIO drive strength and pull-up disable is not always adjustable for the GPIO port. Some control bits cannot be changed (se[e Table 84\)](#page-69-1).

Table 85. GPxDAT Registers

 $X = 0, 1, 2,$ or 3.

GPxDAT are Port x configuration and data registers. They configure the direction of the GPIO pins of Port x, set the output value for the pins configured as output, and store the input value of the pins configured as input.

Table 86. GPxDAT MMR Bit Descriptions

Table 87. GPxSET Registers

 $1X = 0, 1, 2,$ or 3.

GPxSET are data set Port x registers.

Table 88. GPxSET MMR Bit Descriptions

Table 89. GPxCLR Registers

 $1X = 0, 1, 2,$ or 3.

GPxCLR are data clear Port x registers.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 90. GPxCLR MMR Bit Descriptions

SERIAL PORT MUX

The serial port mux multiplexes the serial port peripherals (an SPI, UART, and two $I²Cs$) and the programmable logic array (PLA) to a set of 10 GPIO pins. Each pin must be configured to one of its specific I/O functions as described in [Table 91.](#page-70-3)

Table 91. SPM Configuration

[Table 91](#page-70-3) also details the mode for each of the SPMMUX pins. This configuration must be done via the GP0CON, GP1CON, and GP2CON MMRs. By default, these 10 pins are configured as GPIOs.

UART SERIAL INTERFACE

The UART peripheral is a full-duplex, universal, asynchronous receiver/transmitter. It is fully compatible with the 16,450 serial port standard. The UART performs serial-to-parallel conversions on data characters received from a peripheral device or modem, and parallel-to-serial conversions on data characters received from the CPU. The UART includes a fractional divider for baud rate generation and has a network addressable mode. The UART function is made available on the 10 pins of the ADuC7019/20/ 21/22/24/25/26/27/28/29 (se[e Table 92\)](#page-70-4).

Table 92. UART Signal Description

The serial communication adopts an asynchronous protocol, which supports various word lengths, stop bits, and parity generation options selectable in the configuration register.

Baud Rate Generation

There are two ways of generating the UART baud rate, normal 450 UART baud rate generation and the fractional divider.

Normal 450 UART Baud Rate Generation

The baud rate is a divided version of the core clock using the values in the COMDIV0 and COMDIV1 MMRs (16-bit value, DL).

$$
BaudRate = \frac{41.78MHz}{2^{CD} - 16 \times 2 \times DL}
$$

[Table 93 g](#page-71-5)ives some common baud rate values.

Table 93. Baud Rate Using the Normal Baud Rate Generator

Fractional Divider

The fractional divider, combined with the normal baud rate generator, produces a wider range of more accurate baud rates.

Figure 75. Baud Rate Generation Options

Calculation of the baud rate using fractional divider is as follows:

$$
Baud Rate = \frac{41.78 MHz}{2^{CD} \times 16 \times DL \times 2 \times \left(M + \frac{N}{2048}\right)}
$$

$$
M + \frac{N}{2048} = \frac{41.78 MHz}{Baud Rate \times 2^{CD} \times 16 \times DL \times 2}
$$

For example, generation of 19,200 baud with CD bits $= 3$ [\(Table 93 g](#page-71-5)ives $DL = 0x08$) is

$$
M + \frac{N}{2048} = \frac{41.78 \text{ MHz}}{19200 \times 2^3 \times 16 \times 8 \times 2}
$$

$$
M + \frac{N}{2048} = 1.06
$$

$$
2048\\
$$

where: $M = 1$

$$
N = 0.06 \times 2048 = 128
$$

Baud Rate =
$$
\frac{41.78 \text{ MHz}}{2^3 \times 16 \times 8 \times 2 \times \frac{128}{2048}}
$$

where:

Baud Rate = 19,200 bps

Error = 0%, compared to 6.25% with the normal baud rate generator.

UART Register Definitions

The UART interface consists of 12 registers: COMTX, COMRX, COMDIV0, COMIEN0, COMDIV1, COMIID0, COMCON0, COMCON1, COMSTA0, COMSTA1, COMSCR, and COMDIV2.

Table 94. COMTX Register

COMTX is an 8-bit transmit register.

Table 95. COMRX Register

COMRX is an 8-bit receive register.

Table 96. COMDIV0 Register

COMDIV0 is a low byte divisor latch. COMTX, COMRX, and COMDIV0 share the same address location. COMTX and COMRX can be accessed when Bit 7 in the COMCON0 register is cleared. COMDIV0 can be accessed when Bit 7 of COMCON0 is set.

Table 97. COMIEN0 Register

COMIEN0 is the interrupt enable register.

Table 98. COMIEN0 MMR Bit Descriptions

Table 99. COMDIV1 Register

COMDIV1 is a divisor latch (high byte) register.

Table 100. COMIID0 Register

COMIID0 is the interrupt identification register.

Table 101. COMIID0 MMR Bit Descriptions

Table 102. COMCON0 Register

COMCON0 is the line control register.

Table 103. COMCON0 MMR Bit Descriptions

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 104. COMCON1 Register

COMCON1 is the modem control register.

Table 105. COMCON1 MMR Bit Descriptions

Table 106. COMSTA0 Register

COMSTA0 is the line status register.

Table 107. COMSTA0 MMR Bit Descriptions

Table 108. COMSTA1 Register

COMSTA1 is a modem status register.

Table 109. COMSTA1 MMR Bit Descriptions

Table 110. COMSCR Register

COMSCR is an 8-bit scratch register used for temporary storage. It is also used in network addressable UART mode.

Table 111. COMDIV2 Register

COMDIV2 is a 16-bit fractional baud divide register.

Table 112. COMDIV2 MMR Bit Descriptions

Network Addressable UART Mode

This mode connects the MicroConverter to a 256-node serial network, either as a hardware single master or via software in a multimaster network. Bit 7 (ENAM) of the COMIEN1 register must be set to enable UART in network addressable mode (see [Table 114\)](#page-73-0). Note that there is no parity check in this mode.

Network Addressable UART Register Definitions

Four additional registers, COMIEN0, COMIEN1, COMIID1, and COMADR are used in network addressable UART mode only.

In network address mode, the least significant bit of the COMIEN1 register is the transmitted network address control bit. If set to 1, the device is transmitting an address. If cleared to 0, the device is transmitting data. For example, the following masterbased code transmits the slave's address followed by the data:

COMIEN1 = $0xE7$; //Setting ENAM, E9BT, E9BR, ETD, NABP

COMTX = 0xA0; // Slave address is 0xA0

 while(!(0x020==(COMSTA0 & 0x020))){} // wait for adr tx to finish.

 $COMIEN1 = 0xE6$; // Clear NAB bit to indicate Data is coming

COMTX = $0x55$; // Tx data to slave: $0x55$

Table 113. COMIEN1 Register

COMIEN1 is an 8-bit network enable register.

Table 114. COMIEN1 MMR Bit Descriptions

Table 115. COMIID1 Register

COMIID1 is an 8-bit network interrupt register. Bit 7 to Bit 4 are reserved (see Table 116).

Table 116. COMIID1 MMR Bit Descriptions

Note that to receive a network address interrupt, the slave must ensure that Bit 0 of COMIEN0 (enable receive buffer full interrupt) is set to 1.

Table 117. COMADR Register

COMADR is an 8-bit, read/write network address register that holds the address checked for by the network addressable UART. Upon receiving this address, the device interrupts the processor and/or sets the appropriate status bit in COMIID1.

SERIAL PERIPHERAL INTERFACE

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) integrate a complete hardware serial peripheral interface (SPI) on-chip. SPI is an industry standard, synchronous serial interface that allows eight bits of data to be synchronously transmitted and simultaneously received, that is, full duplex up to a maximum bit rate of 3.48 Mb, as shown i[n Table 118.](#page-74-0) The SPI interface is not operational with core clock divider (CD) bits. $POWCON[2:0] = 6$ or 7 in master mode.

The SPI port can be configured for master or slave operation. and typically consists of four pins: MISO (P1.5), MOSI (P1.6), SCLK (P1.4), and \overline{CS} (P1.7).

On the transmit side, the SPITX register (and a TX shift register outside it) loads data onto the transmit pin (in slave mode, MISO; in master mode, MOSI). The transmit status bit, Bit 0, in SPISTA indicates whether there is valid data in the SPITX register.

Similarly, the receive data path consists of the SPIRX register (and an RX shift register). SPISTA, Bit 3 indicates whether there is valid data in the SPIRX register. If valid data in the SPIRX register is overwritten or if valid data in the RX shift register is discarded, SPISTA, Bit 5 (the overflow bit) is set.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

MISO (Master In, Slave Out) Pin

The MISO pin is configured as an input line in master mode and an output line in slave mode. The MISO line on the master (data in) should be connected to the MISO line in the slave device (data out). The data is transferred as byte wide (8-bit) serial data, MSB first.

MOSI (Master Out, Slave In) Pin

The MOSI pin is configured as an output line in master mode and an input line in slave mode. The MOSI line on the master (data out) should be connected to the MOSI line in the slave device (data in). The data is transferred as byte wide (8-bit) serial data, MSB first.

SCLK (Serial Clock I/O) Pin

The master serial clock (SCLK) is used to synchronize the data being transmitted and received through the MOSI SCLK period. Therefore, a byte is transmitted/received after eight SCLK periods. The SCLK pin is configured as an output in master mode and as an input in slave mode.

In master mode, the polarity and phase of the clock are controlled by the SPICON register, and the bit rate is defined in the SPIDIV register as follows:

$$
f_{\text{SERIAL CLOCK}} = \frac{f_{\text{UCLK}}}{2 \times (1 + SPIDIV)}
$$

The maximum speed of the SPI clock is dependent on the clock divider bits and is summarized in [Table 118.](#page-74-0)

In slave mode, the SPICON register must be configured with the phase and polarity of the expected input clock. The slave accepts data from an external master up to 10.4 Mb at $CD = 0$. The formula to determine the maximum speed is as follows:

$$
f_{\text{SERIAL CLOCK}} = \frac{f_{\text{HCLK}}}{4}
$$

In both master and slave modes, data is transmitted on one edge of the SCL signal and sampled on the other. Therefore, it is important that the polarity and phase be configured the same for the master and slave devices.

Chip Select (CS Input) Pin

In SPI slave mode, a transfer is initiated by the assertion of CS, which is an active low input signal. The SPI port then transmits and receives 8-bit data until the transfer is concluded by deassertion of \overline{CS} . In slave mode, \overline{CS} is always an input.

SPI Registers

The following MMR registers are used to control the SPI interface: SPISTA, SPIRX, SPITX, SPIDIV, and SPICON.

Table 119. SPISTA Register

SPISTA is an 8-bit read-only status register. Only Bit 1 or Bit 4 of this register generates an interrupt. Bit 6 of the SPICON register determines which bit generates the interrupt.

Table 120. SPISTA MMR Bit Descriptions

Table 121. SPIRX Register

SPIRX is an 8-bit, read-only receive register.

Table 122. SPITX Register

SPITX is an 8-bit, write-only transmit register.

Table 123. SPIDIV Register

SPIDIV is an 8-bit, serial clock divider register.

Table 124. SPICON Register

SPICON is a 16-bit control register.

Table 125. SPICON MMR Bit Descriptions

I 2 C-COMPATIBLE INTERFACES

Th[e ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 s](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)upport two licensed I²C interfaces. The I²C interfaces are both implemented as a hard-ware master and a full slave interface. Because the two I^2C inter-faces are identical, this data sheet describes only I2C0 in detail. Note that the two masters and one of the slaves have individual interrupts (see th[e Interrupt System s](#page-83-0)ection).

Note that when configured as an I²C master device, the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 c](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)annot generate a repeated start condition.

The two GPIO pins used for data transfer, SDAx and SCLx, are configured in a wired-AND format that allows arbitration in a multimaster system. These pins require external pull-up resistors. Typical pull-up values are 10 kΩ.

The I²C bus peripheral address in the I²C bus system is programmed by the user. This ID can be modified any time a transfer is not in progress. The user can configure the interface to respond to four slave addresses.

The transfer sequence of an I^2C system consists of a master device initiating a transfer by generating a start condition while the bus is idle. The master transmits the slave device address and the direction of the data transfer during the initial address transfer. If the master does not lose arbitration and the slave acknowledges, the data transfer is initiated. This continues until the master issues a stop condition and the bus becomes idle.

The ^PC peripheral can be configured only as a master or slave at any given time. The same I²C channel cannot simultaneously support master and slave modes.

Serial Clock Generation

The I²C master in the system generates the serial clock for a transfer. The master channel can be configured to operate in fast mode (400 kHz) or standard mode (100 kHz).

The bit rate is defined in the I2C0DIV MMR as follows:

$$
f_{\text{SERIAL CLOCK}} = \frac{f_{\text{UCLK}}}{(2 + DWH) + (2 + DWL)}
$$

where:

 f_{UCLK} = clock before the clock divider. *DIVH* = the high period of the clock. *DIVL* = the low period of the clock.

Thus, for 100 kHz operation,

 $DIVH = DIVL = 0xCF$

and for 400 kHz,

 $DIVH = 0x28$, $DIVL = 0x3C$

The I2CxDIV registers correspond to DIVH:DIVL.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Slave Addresses

The registers I2C0ID0, I2C0ID1, I2C0ID2, and I2C0ID3 contain the device IDs. The device compares the four I2C0IDx registers to the address byte. To be correctly addressed, the seven MSBs of either ID register must be identical to that of the seven MSBs of the first received address byte. The LSB of the ID registers (the transfer direction bit) is ignored in the process of address recognition.

I 2 C Registers

The ^PC peripheral interface consists of 18 MMRs, which are discussed in this section.

Table 126. I2CxMSTA Registers

I2CxMSTA are status registers for the master channel.

Table 127. I2C0MSTA MMR Bit Descriptions

Table 128. I2CxSSTA Registers

I2CxSSTA are status registers for the slave channel.

Table 129. I2C0SSTA MMR Bit Descriptions

Table 130. I2CxSRX Registers

I2CxSRX are receive registers for the slave channel.

Table 131. I2CxSTX Registers

I2CxSTX are transmit registers for the slave channel.

Table 132. I2CxMRX Registers

I2CxMRX are receive registers for the master channel.

Table 133. I2CxMTX Registers

I2CxMTX are transmit registers for the master channel.

Table 134. I2CxCNT Registers

I2CxCNT are 3-bit, master receive, data count registers. If a master read transfer sequence is initiated, the I2CxCNT registers denote the number of bytes (−1) to be read from the slave device. By default, this counter is 0, which corresponds to the one byte expected.

Table 135. I2CxADR Registers

I2CxADR are master address byte registers. The I2CxADR value is the device address that the master wants to communicate with. It automatically transmits at the start of a master transfer sequence if there is no valid data in the I2CxMTX register when the master enable bit is set.

Table 136. I2CxBYTE Registers

I2CxBYTE are broadcast byte registers. Data written to these registers does not go through the TxFIFO. This data is transmitted at the start of a transfer sequence before the address. After the byte is transmitted and acknowledged, the I²C expects another byte written in I2CxBYTE or an address written to the address register.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 137. I2CxALT Registers

I2CxALT are hardware general call ID registers used in slave mode.

Table 139. I2C0CFG MMR Bit Descriptions

Table 138. I2CxCFG Registers

I2CxCFG are configuration registers.

Table 140. I2CxDIV Registers

I2CxDIV are the clock divider registers.

Table 141. I2CxIDx Registers

I2CxID0, I2CxID1, I2CxID2, and I2CxID3 are slave address device ID registers of I2Cx.

Table 142. I2CxCCNT Registers

I2CxCCNT are 8-bit start/stop generation counters. They hold off SDA low for start and stop conditions.

Table 143. I2CxFSTA Registers

I2CxFSTA are FIFO status registers.

Table 144. I2C0FSTA MMR Bit Descriptions

PROGRAMMABLE LOGIC ARRAY (PLA)

Every [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 i](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ntegrates a fully programmable logic array (PLA) that consists of two independent but interconnected PLA blocks. Each block consists of eight PLA elements, giving each part a total of 16 PLA elements.

Each PLA element contains a two-input lookup table that can be configured to generate any logic output function based on two inputs and a flip-flop. This is represented in [Figure 76.](#page-80-0)

In total, 30 GPIO pins are available on each ADuC7019/20/21/ 22/24/25/26/27/28/29 for the PLA. These include 16 input pins and 14 output pins, which msut be configured in the GPxCON register as PLA pins before using the PLA. Note that the comparator output is also included as one of the 16 input pins.

The PLA is configured via a set of user MMRs. The output(s) of the PLA can be routed to the internal interrupt system, to the CONVSTART signal of the ADC, to an MMR, or to any of the 16 PLA output pins.

The two blocks can be interconnected as follows:

- Output of Element 15 (Block 1) can be fed back to Input 0 of Mux 0 of Element 0 (Block 0).
- Output of Element 7 (Block 0) can be fed back to the Input 0 of Mux 0 of Element 8 (Block 1).

Table 145. Element Input/Output

PLA MMRs Interface

The PLA peripheral interface consists of the 22 MMRs described in this section.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 146. PLAELMx Registers

PLAELMx are Element 0 to Element 15 control registers. They configure the input and output mux of each element, select the function in the lookup table, and bypass/use the flip-flop. See [Table 147](#page-80-1) an[d Table 152.](#page-81-0)

Table 147. PLAELMx MMR Bit Descriptions

Table 148. PLACLK Register

PLACLK is the clock selection for the flip-flops of Block 0 and Block 1. Note that the maximum frequency when using the GPIO pins as the clock input for the PLA blocks is 44 MHz.

Table 149. PLACLK MMR Bit Descriptions

Table 152. Feedback Configuration

Table 150. PLAIRQ Register

PLAIRQ enables IRQ0 and/or IRQ1 and selects the source of the IRQ.

Table 151. PLAIRQ MMR Bit Descriptions

Bit Value PLAELM0 PLAELM1 to PLAELM7 PLAELM8 PLAELM9 to PLAELM15 10:9 | 00 | Element 15 | Element 0 | Element 7 | Element 8 01 | Element 2 | Element 2 | Element 10 | Element 10 | Element 10 10 | Element 4 | Element 4 | Element 12 | Element 12 | Element 12 11 | Element 6 | Element 6 | Element 14 | Element 14 | Element 14 8:7 $\begin{array}{|c|c|c|c|c|}\n\hline\n8:7 & \begin{array}{|c|c|c|}\n\hline\n8:7 & \begin{array}{|c|c|c|}\n\hline\n8:8 & \begin{array}{|c|c|c|}\n\$ 01 | Element 3 | Element 3 | Element 11 | Element 11 | Element 11 10 | Element 5 | Element 5 | Element 13 | Element 13 11 | Element 7 | Element 7 | Element 15 | Element 15 | Element 15

Table 153. PLAADC Register

PLAADC is the PLA source for the ADC start conversion signal.

Table 154. PLAADC MMR Bit Descriptions

Table 155. PLADIN Register

PLADIN is a data input MMR for PLA.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 156. PLADIN MMR Bit Descriptions

Table 157. PLADOUT Register

PLADOUT is a data output MMR for PLA. This register is always updated.

Table 158. PLADOUT MMR Bit Descriptions

Table 159. PLALCK Register

PLALCK is a PLA lock option. Bit 0 is written only once. When set, it does not allow modifying any of the PLA MMRs, except PLADIN. A PLA tool is provided in the development system to easily configure the PLA.

PROCESSOR REFERENCE PERIPHERALS

INTERRUPT SYSTEM

There are 23 interrupt sources on the ADuC7019/20/21/22/ 24/25/26/27/28/29 that are controlled by the interrupt controller. Most interrupts are generated from the on-chip peripherals, such as ADC and UART. Four additional interrupt sources are generated from external interrupt request pins, IRQ0, IRQ1, IRQ2, and IRQ3. The ARM7TDMI CPU core only recognizes interrupts as one of two types: a normal interrupt request IRQ or a fast interrupt request FIQ. All the interrupts can be masked separately.

The control and configuration of the interrupt system are managed through nine interrupt-related registers, four dedicated to IRQ, and four dedicated to FIQ. An additional MMR is used to select the programmed interrupt source. The bits in each IRQ and FIQ register (except for Bit 23) represent the same interrupt source as described in [Table 160.](#page-83-1)

Table 160. IRQ/FIQ MMRs Bit Description

IRQ

The interrupt request (IRQ) is the exception signal to enter the IRQ mode of the processor. It is used to service general-purpose interrupt handling of internal and external events.

The four 32-bit registers dedicated to IRQ are IRQSTA, IRQSIG, IRQEN, and IRQCLR.

Table 161. IRQSTA Register

IRQSTA (read-only register) provides the current-enabled IRQ source status. When set to 1, that source should generate an active IRQ request to the ARM7TDMI core. There is no priority encoder or interrupt vector generation. This function is implemented in software in a common interrupt handler routine. All 32 bits are logically OR'ed to create the IRQ signal to the ARM7TDMI core.

Table 162. IRQSIG Register

1X indicates an undefined value.

IRQSIG reflects the status of the different IRQ sources. If a peripheral generates an IRQ signal, the corresponding bit in the IRQSIG is set; otherwise, it is cleared. The IRQSIG bits are cleared when the interrupt in the particular peripheral is cleared. All IRQ sources can be masked in the IRQEN MMR. IRQSIG is read only.

Table 163. IRQEN Register

IRQEN provides the value of the current enable mask. When each bit is set to 1, the source request is enabled to create an IRQ exception. When each bit is set to 0, the source request is disabled or masked, which does not create an IRQ exception.

Note that to clear an already enabled interrupt source, the user must set the appropriate bit in the IRQCLR register. Clearing an interrupt's IRQEN bit does not disable the interrupt.

Table 164. IRQCLR Register

IRQCLR (write-only register) clears the IRQEN register in order to mask an interrupt source. Each bit set to 1 clears the corresponding bit in the IRQEN register without affecting the remaining bits. The pair of registers, IRQEN and IRQCLR, independently manipulates the enable mask without requiring an atomic read-modify-write.

FIQ

The fast interrupt request (FIQ) is the exception signal to enter the FIQ mode of the processor. It is provided to service data transfer or communication channel tasks with low latency. The FIQ interface is identical to the IRQ interface providing the second-level interrupt (highest priority). Four 32-bit registers are dedicated to FIQ: FIQSIG, FIQEN, FIQCLR, and FIQSTA.

Table 165. FIQSTA Register

Table 166. FIQSIG Register

¹X indicates an undefined value.

Table 167. FIQEN Register

Table 168. FIQCLR Register

Bit 31 to Bit 1 of FIQSTA are logically OR'd to create the FIQ signal to the core and to Bit 0 of both the FIQ and IRQ registers (FIQ source).

The logic for FIQEN and IRQEN does not allow an interrupt source to be enabled in both IRQ and FIQ masks. A bit set to 1 in FIQEN does, as a side effect, clear the same bit in IRQEN. Also, a bit set to 1 in IRQEN does, as a side effect, clear the same bit in FIQEN. An interrupt source can be disabled in both the IRQEN and FIQEN masks.

Note that to clear an already enabled FIQ source, the user must set the appropriate bit in the FIQCLR register. Clearing an interrupt's FIQEN bit does not disable the interrupt.

Programmed Interrupts

Because the programmed interrupts are nonmaskable, they are controlled by another register, SWICFG, which simultaneously writes into the IRQSTA and IRQSIG registers and/or the FIQSTA and FIQSIG registers. The 32-bit SWICFG register is dedicated to software interrupts(see [Table 170\)](#page-84-0). This MMR allows the control of a programmed source interrupt.

Table 169. SWICFG Register

Table 170. SWICFG MMR Bit Descriptions

Note that any interrupt signal must be active for at least the equivalent of the interrupt latency time, which is detected by the interrupt controller and by the user in the IRQSTA/FIQSTA register.

TIMERS

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 h](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ave four generalpurpose timer/counters.

- Timer0
- Timer1
- Timer2 or wake-up timer
- Timer3 or watchdog timer

These four timers in their normal mode of operation can be either free running or periodic.

In free-running mode, the counter decreases from the maximum value until zero scale and starts again at the minimum value. (It also increases from the minimum value until full scale and starts again at the maximum value.)

In periodic mode, the counter decrements/increments from the value in the load register (TxLD MMR) until zero/full scale and starts again at the value stored in the load register.

The timer interval is calculated as follows:

If the timer is set to count down then

$$
Interval = \frac{(TxLD) \times Prescaler}{SourceClock}
$$

If the timer is set to count up, then

$$
Interval = \frac{(Fs - TxLD) \times \text{Prescalar}}{\text{SourceClock}}
$$

The value of a counter can be read at any time by accessing its value register (TxVAL). Note that when a timer is being clocked from a clock other than core clock, an incorrect value may be read (due to an asynchronous clock system). In this configuration, TxVAL should always be read twice. If the two readings are different, it should be read a third time to get the correct value.

Timers are started by writing in the control register of the corresponding timer (TxCON).

ADuC7019/20/21/22/24/25/26/27/28/29 Data Sheet

In normal mode, an IRQ is generated each time the value of the counter reaches zero when counting down. It is also generated each time the counter value reaches full scale when counting up. An IRQ can be cleared by writing any value to clear the register of that particular timer (TxCLRI).

When using an asynchronous clock-to-clock timer, the interrupt in the timer block may take more time to clear than the time it takes for the code in the interrupt routine to execute. Ensure that the interrupt signal is cleared before leaving the interrupt service routine. This can be done by checking the IRQSTA MMR.

Hour:Minute:Second:1/128 Format

To use the timer in hour:minute:second:hundredths format, select the 32,768 kHz clock and prescaler of 256. The hundredths field does not represent milliseconds but 1/128 of a second (256/32,768). The bits representing the hour, minute, and second are not consecutive in the register. This arrangement applies to TxLD and TxVAL when using the hour:minute:second:hundredths format as set in TxCON[5:4]. See [Table 171](#page-85-0) for additional details.

Table 171. Hour:Minnute:Second:Hundredths Format

Timer0 (RTOS Timer)

Timer0 is a general-purpose, 16-bit timer (count down) with a programmable prescaler (se[e Figure 77\)](#page-85-1). The prescaler source is the core clock frequency (HCLK) and can be scaled by factors of 1, 16, or 256.

Timer0 can be used to start ADC conversions as shown in the block diagram i[n Figure 77.](#page-85-1)

The Timer0 interface consists of four MMRs: T0LD, T0VAL, T0CON, and T0CLRI.

Table 172. T0LD Register

T0LD is a 16-bit load register.

Table 173. T0VAL Register

T0VAL is a 16-bit read-only register representing the current state of the counter.

Table 174. T0CON Register

T0CON is the configuration MMR described in [Table 175.](#page-85-2)

Table 175. T0CON MMR Bit Descriptions

Table 176. T0CLRI Register

T0CLRI is an 8-bit register. Writing any value to this register clears the interrupt.

Timer1 (General-Purpose Timer)

Timer1 is a general-purpose, 32-bit timer (count down or count up) with a programmable prescaler. The source can be the 32 kHz external crystal, the core clock frequency, or an external GPIO (P1.0 or P0.6). The maximum frequency of the clock input is 44 Mhz). This source can be scaled by a factor of 1, 16, 256, or 32,768.

The counter can be formatted as a standard 32-bit value or as hours: minutes: seconds: hundredths.

Timer1 has a capture register (T1CAP) that can be triggered by a selected IRQ source initial assertion. This feature can be used to determine the assertion of an event more accurately than the precision allowed by the RTOS timer when the IRQ is serviced.

Timer1 can be used to start ADC conversions as shown in the block diagram i[n Figure 78.](#page-86-0)

Figure 78. Timer1 Block Diagram

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

The Timer1 interface consists of five MMRs: T1LD, T1VAL, T1CON, T1CLRI, and T1CAP.

Table 177. T1LD Register

T1LD is a 32-bit load register.

Table 178. T1VAL Register

T1VAL is a 32-bit read-only register that represents the current state of the counter.

Table 179. T1CON Register

T1CON is the configuration MMR described in [Table 180.](#page-87-0)

Table 180. T1CON MMR Bit Descriptions

Table 181. T1CLRI Register

T1CLRI is an 8-bit register. Writing any value to this register clears the Timer1 interrupt.

Table 182. T1CAP Register

T1CAP is a 32-bit register. It holds the value contained in T1VAL when a particular event occurs. This event must be selected in T1CON.

Timer2 (Wake-Up Timer)

Timer2 is a 32-bit wake-up timer (count down or count up) with a programmable prescaler. The source can be the 32 kHz external crystal, the core clock frequency, or the internal 32 kHz oscillator. The clock source can be scaled by a factor of 1, 16, 256, or 32,768. The wake-up timer continues to run when the core clock is disabled.

The counter can be formatted as plain 32-bit value or as hours: minutes: seconds: hundredths.

The Timer2 interface consists of four MMRs: T2LD, T2VAL, T2CON, and T2CLRI.

Table 183. T2LD Register

T2LD is a 32-bit register load register.

Table 184. T2VAL Register

T2VAL is a 32-bit read-only register that represents the current state of the counter.

Table 185. T2CON Register

T2CON is the configuration MMR described in [Table 186.](#page-88-0)

Table 186. T2CON MMR Bit Descriptions

Table 187. T2CLRI Register

T2CLRI is an 8-bit register. Writing any value to this register clears the Timer2 interrupt.

Timer3 (Watchdog Timer)

Timer3 has two modes of operation: normal mode and watchdog mode. The watchdog timer is used to recover from an illegal software state. Once enabled, it requires periodic servicing to prevent it from forcing a processor reset.

Normal Mode

Timer3 in normal mode is identical to Timer0, except for the clock source and the count-up functionality. The clock source is 32 kHz from the PLL and can be scaled by a factor of 1, 16, or 256 (se[e Figure 80\)](#page-88-1).

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Watchdog Mode

Watchdog mode is entered by setting Bit 5 in the T3CON MMR. Timer3 decreases from the value present in the T3LD register to 0. T3LD is used as the timeout. The maximum timeout can be 512 sec, using the prescaler/256, and full scale in T3LD. Timer3 is clocked by the internal 32 kHz crystal when operating in watchdog mode. Note that to enter watchdog mode successfully, Bit 5 in the T3CON MMR must be set after writing to the T3LD MMR.

If the timer reaches 0, a reset or an interrupt occurs, depending on Bit 1 in the T3CON register. To avoid reset or interrupt, any value must be written to T3CLRI before the expiration period. This reloads the counter with T3LD and begins a new timeout period.

When watchdog mode is entered, T3LD and T3CON are writeprotected. These two registers cannot be modified until a reset clears the watchdog enable bit, which causes Timer3 to exit watchdog mode.

The Timer3 interface consists of four MMRs: T3LD, T3VAL, T3CON, and T3CLRI.

Table 188. T3LD Register

T3LD is a 16-bit register load register.

Table 189. T3VAL Register

T3VAL is a 16-bit read-only register that represents the current state of the counter.

Table 190. T3CON Register

T3CON is the configuration MMR described in [Table 191.](#page-89-0)

Table 191. T3CON MMR Bit Descriptions

Table 192. T3CLRI Register

T3CLRI is an 8-bit register. Writing any value to this register on successive occassions clears the Timer3 interrupt in normal mode or resets a new timeout period in watchdog mode*.*

Note that the user must perform successive writes to this register to ensure resetting the timeout period.

Secure Clear Bit (Watchdog Mode Only)

The secure clear bit is provided for a higher level of protection. When set, a specific sequential value must be written to T3CLRI to avoid a watchdog reset. The value is a sequence generated by the 8-bit linear feedback shift register (LFSR) polynomial = $X8 + X6 + X5 + X + 1$, as shown in Figure 81.

The initial value or seed is written to T3CLRI before entering watchdog mode. After entering watchdog mode, a write to T3CLRI must match this expected value. If it matches, the LFSR is advanced to the next state when the counter reload occurs. If it fails to match the expected state, a reset is immediately generated, even if the count has not yet expired.

The value 0x00 should not be used as an initial seed due to the properties of the polynomial. The value 0x00 is always guaranteed to force an immediate reset. The value of the LFSR cannot be read; it must be tracked/generated in software.

The following is an example of a sequence:

- 1. Enter initial seed, 0xAA, in T3CLRI before starting Timer3 in watchdog mode.
- 2. Enter 0xAA in T3CLRI; Timer3 is reloaded.
- 3. Enter 0x37 in T3CLRI; Timer3 is reloaded.
- 4. Enter 0x6E in T3CLRI; Timer3 is reloaded.
- 5. Enter 0x66. 0xDC was expected; the watchdog resets the chip.

EXTERNAL MEMORY INTERFACING

The ADuC7026 and ADuC7027 are the only models in their series that feature an external memory interface. The external memory interface requires a larger number of pins. This is why it is only available on larger pin count packages. The XMCFG MMR must be set to 1 to use the external port.

Although 32-bit addresses are supported internally, only the lower 16 bits of the address are on external pins.

The memory interface can address up to four 128 kB blocks of asynchronous memory (SRAM or/and EEPROM).

The pins required for interfacing to an external memory are shown in [Table 193.](#page-89-2)

Table 193. External Memory Interfacing Pins

There are four external memory regions available, as described in [Table 194.](#page-89-3) Associated with each region are the MS[3:0] pins. These signals allow access to the particular region of external memory. The size of each memory region can be 128 kB maximum, 64 k \times 16 or 128 k \times 8. To access 128 k with an 8-bit memory, an extra address line (A16) is provided (see the example in [Figure 82\)](#page-90-0). The four regions are configured independently.

Table 194. Memory Regions

Each external memory region can be controlled through three MMRs: XMCFG, XMxCON, and XMxPAR.

Figure 82. Interfacing to External EEPROM/RAM

04955-039

139

Table 195. XMCFG Register

XMCFG is set to 1 to enable external memory access. This must be set to 1 before any port pins function as external memory access pins. The port pins must also be individually enabled via the GPxCON MMR.

Table 196. XMxCON Registers

XMxCON are the control registers for each memory region. They allow the enabling/disabling of a memory region and control the data bus width of the memory region.

Table 197. XMxCON MMR Bit Descriptions

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

Table 198. XMxPAR Registers

XMxPAR are registers that define the protocol used for accessing the external memory for each memory region.

Table 199. XMxPAR MMR Bit Descriptions

[Figure 83,](#page-91-0) [Figure 84,](#page-91-1) [Figure 85,](#page-92-0) an[d Figure 86](#page-92-1) show the timing for a read cycle, a read cycle with address hold and bus turn cycles, a write cycle with address and write hold cycles, and a write cycle with wait sates, respectively.

ADuC7019/20/21/22/24/25/26/27/28/29 Data Sheet

Figure 84. External Memory Read Cycle with Address Hold and Bus Turn Cycles

HARDWARE DESIGN CONSIDERATIONS **POWER SUPPLIES**

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 o](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)perational power supply voltage range is 2.7 V to 3.6 V. Separate analog and digital power supply pins (AV_{DD} and IOV_{DD} , respectively) allow AV_{DD} to be kept relatively free of noisy digital signals often present on the system IOV_{DD} line. In this mode, the part can also operate with split supplies; that is, it can use different voltage levels for each supply. For example, the system can be designed to operate with an IOVDD voltage level of 3.3 V whereas the AV_{DD} level can be at 3 V or vice versa. A typical split supply configuration is shown i[n Figure 87.](#page-93-0)

Figure 87. External Dual Supply Connections

As an alternative to providing two separate power supplies, the user can reduce noise on AV_{DD} by placing a small series resistor and/or ferrite bead between AV_{DD} and IOV_{DD} and then decoupling AV_{DD} separately to ground. An example of this configuration is shown i[n Figure 88.](#page-93-1) With this configuration, other analog circuitry (such as op amps and voltage reference) can be powered from the AV_{DD} supply line as well.

Figure 88. External Single Supply Connections

Note that in bot[h Figure 87](#page-93-0) an[d Figure 88,](#page-93-1) a large value (10 μF) reservoir capacitor sits on IOV_{DD}, and a separate 10 μF capacitor sits on AV_{DD} . In addition, local small-value (0.1 μ F) capacitors are located at each AV_{DD} and IOV_{DD} pin of the chip. As per standard design practice, be sure to include all of these capacitors and ensure that the smaller capacitors are close to each AV_{DD} pin with trace lengths as short as possible. Connect the ground terminal of each of these capacitors directly to the underlying ground plane. Finally, note that the analog and digital ground pins on the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 m](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)ust be referenced to the same system ground reference point at all times.

IOV_{DD} Supply Sensitivity

The IOV_{DD} supply is sensitive to high frequency noise because it is the supply source for the internal oscillator and PLL circuits. When the internal PLL loses lock, the clock source is removed by a gating circuit from the CPU, and the ARM7TDMI core stops executing code until the PLL regains lock. This feature ensures that no flash interface timings or ARM7TDMI timings are violated.

Typically, frequency noise greater than 50 kHz and 50 mV p-p on top of the supply causes the core to stop working.

If decoupling values recommended in th[e Power Supplies](#page-93-2) section do not sufficiently dampen all noise sources below 50 mV on IOV_{DD}, a filter such as the one shown in Figure 89 is recommended.

Figure 89. Recommended IOV_{DD} Supply Filter

Linear Voltage Regulator

chip voltage regulator.

Each [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29 r](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)equires a single 3.3 V supply, but the core logic requires a 2.6 V supply. An onchip linear regulator generates the 2.6 V from IOV_{DD} for the core logic. The LV_{DD} pin is the 2.6 V supply for the core logic. An external compensation capacitor of 0.47μ F must be connected between LV_{DD} and DGND (as close as possible to these pins) to act as a tank of charge as shown i[n Figure 90.](#page-93-4)

The LV_{DD} pin should not be used for any other chip. It is also recommended to use excellent power supply decoupling on IOV_{DD} to help improve line regulation performance of the on-

GROUNDING AND BOARD LAYOUT RECOMMENDATIONS

As with all high resolution data converters, special attention must be paid to grounding and PC board layout of the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29-](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)based designs to achieve optimum performance from the ADCs and DAC.

Although the parts have separate pins for analog and digital ground (AGND and IOGND), the user must not tie these to two separate ground planes unless the two ground planes are connected very close to the part. This is illustrated in the simplified example shown in [Figure 91a](#page-94-0). In systems where digital and analog ground planes are connected together somewhere else (at the system power supply, for example), the planes cannot be reconnected near the part because a ground loop results. In these cases, tie all the ADuC7019/20/21/ 22/24/25/26/27/28/29 AGND and IOGND pins to the analog ground plane, as illustrated in [Figure 91b](#page-94-0). In systems with only one ground plane, ensure that the digital and analog components are physically separated onto separate halves of the board so that digital return currents do not flow near analog circuitry (and vice versa).

The [ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29 c](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)an then be placed between the digital and analog sections, as illustrated in [Figure 91c](#page-94-0).

In all of these scenarios, and in more complicated real-life applications, the user should pay particular attention to the flow of current from the supplies and back to ground. Make sure the return paths for all currents are as close as possible to the paths the currents took to reach their destinations.

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

For example, do not power components on the analog side (as seen in [Figure 91b](#page-94-0)) with IOV_{DD} because that forces return currents from IOV_{DD} to flow through AGND. Avoid digital currents flowing under analog circuitry, which can occur if a noisy digital chip is placed on the left half of the board (shown in [Figure 91c](#page-94-0)). If possible, avoid large discontinuities in the ground plane(s) such as those formed by a long trace on the same layer because they force return signals to travel a longer path. In addition, make all connections to the ground plane directly, with little or no trace separating the pin from its via to ground.

When connecting fast logic signals (rise/fall time < 5 ns) to any of th[e ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) digital inputs, add a series resistor to each relevant line to keep rise and fall times longer than 5 ns at the part's input pins. A value of 100 Ω or 200 Ω is usually sufficient to prevent high speed signals from coupling capacitively into the part and affecting the accuracy of ADC conversions.

CLOCK OSCILLATOR

The clock source for th[e ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20/](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[21](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) can be generated by the internal PLL or by an external clock input. To use the internal PLL, connect a 32.768 kHz parallel resonant crystal between XCLKI and XCLKO, and connect a capacitor from each pin to ground as shown i[n Figure 92.](#page-94-1) The crystal allows the PLL to lock correctly to give a frequency of 41.78 MHz. If no external crystal is present, the internal oscillator is used to give a typical frequency of 41.78 MHz \pm 3%.

Figure 92. External Parallel Resonant Crystal Connections

To use an external source clock input instead of the PLL (see [Figure 93\)](#page-94-2), Bit 1 and Bit 0 of PLLCON must be modified.The external clock uses P0.7 and XCLK.

Figure 93. Connecting an External Clock Source

Using an external clock source, the ADuC7019/20/21/22/24/ 25/26/27/28/29-specified operational clock speed range is 50 kHz to 44 MHz \pm 1%, which ensures correct operation of the analog peripherals and Flash/EE.

04955-047

ADuC7019/20/21/22/24/25/26/27/28/29 Data Sheet

POWER-ON RESET OPERATION

An internal power-on reset (POR) is implemented on the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29.](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) For LV_{DD} below 2.35 V typical, the internal POR holds the part in reset. As LV_{DD} rises above 2.35 V, an internal timer times out for, typically, 128 ms before the part is released from reset. The user must ensure that the power supply IOV_{DD} reaches a stable 2.7 V minimum level by this time. Likewise, on power-down, the internal POR holds the part in reset until LV_{DD} drops below 2.35 V.

[Figure 94 i](#page-95-0)llustrates the operation of the internal POR in detail.

TYPICAL SYSTEM CONFIGURATION

A typical ADuC7020 configuration is shown in [Figure 95.](#page-95-1) It summarizes some of the hardware considerations discussed in the previous sections. The bottom of the CSP package has an exposed pad that must be soldered to a metal plate on the board for mechanical reasons. The metal plate of the board can be connected to ground.

Figure 95. Typical System Configuration

DEVELOPMENT TOOLS

PC-BASED TOOLS

Four types of development systems are available for the [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) family.

- The [ADuC7026](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) QuickStart Plus is intended for new users who want to have a comprehensive hardware development environment. Because th[e ADuC7026](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) contains the superset of functions available on th[e ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22/](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) [26](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/27/](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29,](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) it is suitable for users who wish to develop on any of the parts in this family. All parts are fully code compatible.
- The [ADuC7019,](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) [ADuC7024,](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) an[d ADuC7026](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) QuickStart systems are intended for users who already have an emulator.

These systems consist of the following PC-based (Windows® compatible) hardware and software development tools.

Hardware

- [ADuC7019](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28/](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) evaluation board
- Serial port programming cable
- RDI-compliant JTAG emulator (included in the ADuC7026 QuickStart Plus only)

Software

- Integrated development environment, incorporating assembler, compiler, and nonintrusive JTAG-based debugger
- Serial downloader software
- Example code

Miscellaneous

CD-ROM documentation

IN-CIRCUIT SERIAL DOWNLOADER

The serial downloader is a Windows application that allows the user to serially download an assembled program to the on-chip program Flash/EE memory via the serial port on a standard PC.

The UART-based serial downloader is included in all the development systems and is usable with th[e ADuC7019/](http://www.analog.com/ADuC7019?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[20](http://www.analog.com/ADuC7020?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/21/](http://www.analog.com/ADuC7021?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) [22](http://www.analog.com/ADuC7022?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/24/](http://www.analog.com/ADuC7024?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[25/](http://www.analog.com/ADuC7025?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[26/](http://www.analog.com/ADuC7026?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[27](http://www.analog.com/ADuC7027?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/28](http://www.analog.com/ADuC7028?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf)[/29](http://www.analog.com/ADuC7029?doc=ADUC7019_20_21_22_24_25_26_27_28_29.pdf) parts that do not contain the I suffix in the [Ordering Guide.](#page-100-0)

An I²C based serial downloader and a USB-to-I²C adaptor board, USB-EA-CONVZ, are also available at [www.analog.com.](http://www.analog.com/) The I²C-based serial downloader is only usable with the part models containing the I suffix (see [Ordering Guide\)](#page-100-0).

ADuC7019/20/21/22/24/25/26/27/28/29 Data Sheet

OUTLINE DIMENSIONS

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

051706-A

Dimensions shown in millimeters

ADuC7019/20/21/22/24/25/26/27/28/29 Data Sheet

Dimensions shown in millimeters

Data Sheet **ADuC7019/20/21/22/24/25/26/27/28/29**

ORDERING GUIDE

¹ Z = RoHS Compliant Part.

² Models ADuC7026 and ADuC7027 include an external memory interface.

³ One of the ADC channels is internally buffered for ADuC7019 models.